

SPECIFICATION  
FOR  
APPROVAL

- ( ) Preliminary Specification  
(●) Final Specification


Title	Customer Approval Sheet for Titan
Customer	Lenovo
Part Number	SD68C74145
SUPPLIER	Holitech
MODEL	HTF065H035
Version	A

SIGNATURE	DATE
_____	_____
_____	_____
_____	_____
Please return 1 copy for your confirmation with your signature and comments.	

APPROVED BY	DATE
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## CONTENT LIST

[illegible]

 motorola <small>a freemove company</small>	Material or Methods Specification	NO. SD68C74145
TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □		
REVISION DATE: 4/7/2020	MEMO:	ISSUE: A
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SCOPE

The purpose of this document is to provide a better understanding of Motorola, Inc.'s requirements for Organic Light Emitting Diode (OLED) Displays to suppliers. Its goal is to clarify quality control procedures and components specifications, so that suppliers ship only 100% acceptable material to Motorola. This document contains specific electrical, optical, mechanical, environmental, packaging, and general Motorola manufacturing, quality, and qualification requirements.

APPLICABLE DOCUMENTS


- 12M80967A78 Motorola Supplier Material Quality Control
- 12G13933A01 Motorola Receiving Barcode Specification
- 12G13933A12 Component Temperature Requirements to Support “Pb-Free” Solder Assembly (if applicable)
- 12S10601A Packaging Requirements for Inbound Shipments to Motorola
- 12G02897W18 Motorola Controlled and Reportable Materials Disclosure
- 12M05053A65 Purchased Material Change Notification Procedure
- 12M09192A78 MOTOROLA PROCESS CHANGE NOTIFICATION PROCEDURE
- 71014125001 MOTOROLA SCT GUIDELINES FOR FPC TESTING AND VALIDATION REQUIREMENTS
- 71014011001 DISPLAY FLEX FABRICATION NOTES
- MBG-S-PQM-061 Motorola Cosmetic Specification for Molded and/or Decorated Plastic Surfaces and Lenses for Handheld Products
- 12G13933C77 Qualification Procedure for LCD Displays
- 12M09192A78 Motorola PCS Process Change Notification Procedure
- 12M09195A44 LCD Mechanical Strength 4-Point Bending Test Method
- 12M09195A47 Display Module Design Validation Test
- 12M09195A43 Display Limit Sample Setup (only if applicable)
- 01019576 Display and Lens Module Assembly ME Drawing
- 72014110001 Display Module Assembly ME Drawing

CAUTION: This specification cannot be distributed to parties outside of Motorola Mobility without first having on file a signed Non-Disclosure Agreement.

If this part does NOT comply with the ESD, Latch-up, or any stress tests as outlined in 12G13933C77, the following note(s) are required to be added.

CAUTION: This device does not meet all the reliability stress test requirements according to Motorola Mobility ALT test conditions at the product level. Testing conditions in ALT at product level may have wider temperature ranges compared with the conditions that are specified in this document.

WARNING: IC's on this product are inherently static sensitive devices. As a result, extreme caution should be used when handling these parts. Every possible precaution should be taken in the manufacturing process to insure that any AMOLED display is not exposed to any static voltages.

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# REQUIREMENT TO 12G13933C77

- This item must be qualified according to the requirements in 12G13933C77.
- Cpk data acquisition:
  - ☐ If this box is checked, Calculate Cp/Cpk on all specified parameters per Motorola 12M80967A78.
  - ☒ If this box is checked, Calculate Cp/Cpk on "[X]" and <ST> parameters only per Motorola 12M80967A78.

# DESCRIPTION

This display is a color Active Matrix Organic Light Emitting Diode display (AMOLED) of glass construction with White pixels on a Black background. The display consists of 1080 (RGBG - Diamond) x 2340 pixels (sub pixel rendered) with a color depth of 16.6 M colors (24 bpp). The display interface is 1 MIPI channel with four DSI lane. The touch interface is via I2C.

This display module is constructed of


- The Organic Light Emitting Diode Display Glass consisting of the top glass plate, top circular polarizer organic material, and LTPS backplane containing the pixel transistors.
- Chip-on-Flex (COF) with the driver ("chip") located at bottom front of panel.
- FPC with the necessary passive/active components.
- Tearing Effect output signal
- Display has 1/3 RAM. (1080x2340x24 ) / 3 = 20,217,600 virtual bits

Note: This platform display may be used on devices with operating systems such as Android, Linux and Java which are open source, and thus may be published and available to the general public. The information contained in any display interaction open source file will be the minimum required to successfully communicate and configure the display module.

Note: Do not ship any samples for any reason without MTPing the correct manufacturer/version numbers in registers A1h, DAh, DBh, DCh. If they are not programmed correctly, they will be rejected as defective. If you have a question regarding the correct programming. contact Motorola DDC immediately.

# CHANGES TO PLATFORM DISPLAY

This document describes a platform display glass and driver intended for reuse in multiple display modules within Motorola. As a result, no element of the display design may change without the written permission from Motorola and an appropriate re-qualification of the display glass and driver. Furthermore, any requests or discussion for changes to the displays from within Motorola must be signed off by the following representatives on the Strategy Commodity Team: the head of the global display commodity team, the head of the Display Design Center.

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# QUALIFICATION REQUIREMENTS


Cpk data must be presented to Component Technologies Engineering for the following process control parameters for initial qualification purposes. Data must be continuously collected for these process control parameters, and be made available to Motorola upon request for the prior 2 EPrs.

Definitions:

Box-X, [X]: Process Control Parameter: Parameter indicative of process control and capability of manufacturing component. Refer to 12M80967A78 for further details.

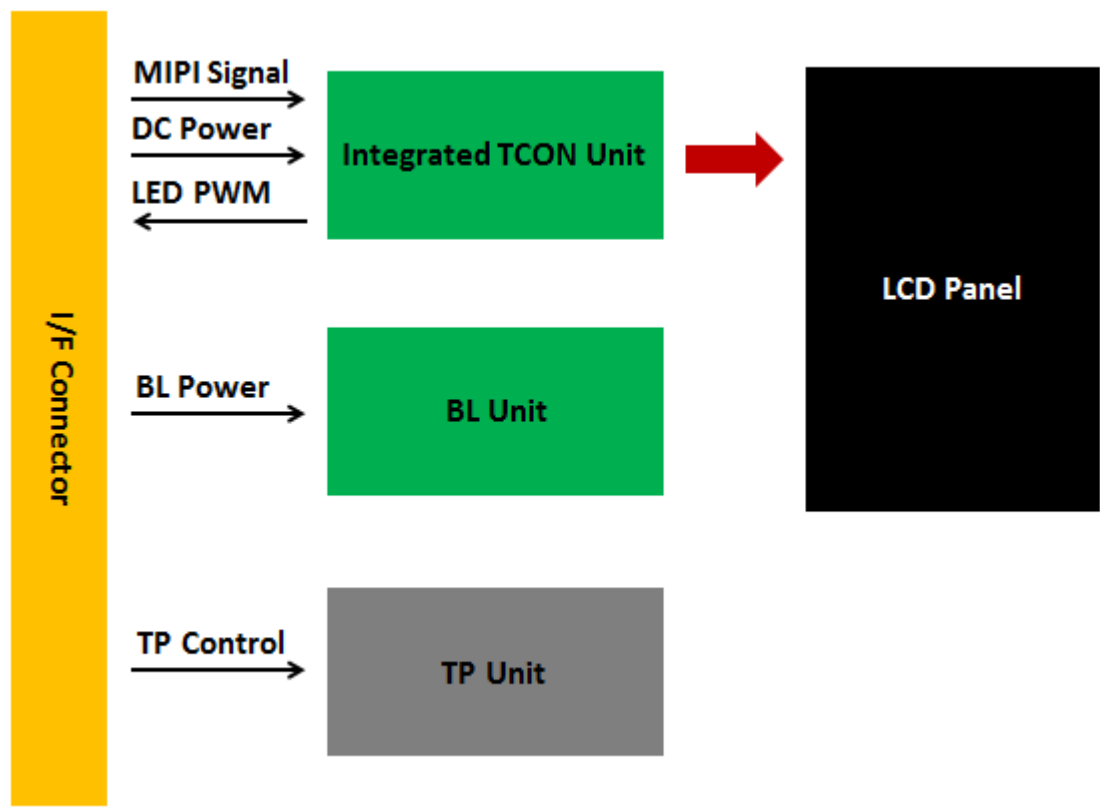
<ST>: Statistical Tolerance Parameter: Used where statistically valid samples are required for non Box-X, [X] parameters for module approval. Refer to 12M80967A78 for further details.



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## 1-1. GENERAL DESCRIPTION

### Block Diagram



### Features

The HTF065H045 is a total solution which direct bonding TFT-LCD module with a driver circuit, a back-light unit and touch sensor. The LCD resolution of a 6.517” contain is 720 x 1600 pixels.

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1-2. General Spec


No	Item	Specification	unit	Remark
1	Screen Size	6.517	inch	-
2	Active Area	67.93(H) x 150.96(V)	mm	-
3	Panel Size	69.73(H) x 155.66(V) x 0.3(D)	mm	-
4	Outline Dimension	70.13 (H)×156.76(V)×1.30 (D)	mm	w/o CG
5	Display Resolution	720RGB(H) x 1600(V)	pixel	-
6	Pixel Pitch	0.03145(H) x0.09435(V)	mm	-
7	Display Method	FFS	-	-
8	Display Mode	Normally Black	-	-
9	Display Color	16.7M Colors	-	8bit
10	Color Gamut	70% (Typ.)	%	NTSC CIE1931
11	Luminance	380 (min.)450 (Typ.)	nit	with Lens, center P
12	Contrast Ratio	1000 (Typ.)	-	center P
13	Viewing Angle	80/80/80/80 (TYP)	°	CR>10(U/D/L/R)
14	Pol Surface Treatment	≥2H	-	-
15	Weight	49.2	g	-
16	D-IC	HX83102-D01QPD1707-CP	-	-
17	Inversion Method	Column inversion	-	-
18	LED Q'ty	16pcs 8S2P (20mA/LED)	ea	String*Parallel
19	Power Consumption	PLCD 120mW(TYP)	mw	@White Pattern
		PBL 896mW(Min.) 960mW(Typ.) 1024mW(Max.)	Mw	@2lane Without Driver IC



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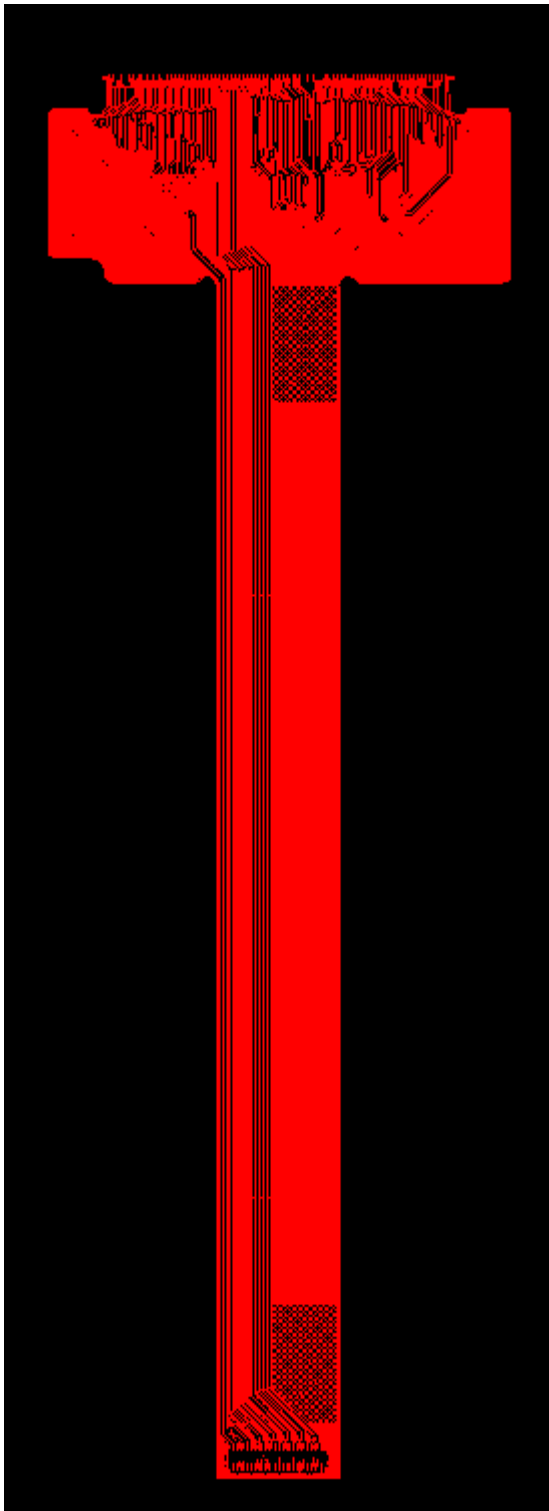
1-3. Key Part List(5pcs average data)

	item	Supplier	Spec/Size	Remark
Cell	TFT Glass	MANTIX	69.73(W) x 155.66 (H) x 0.15 (Thickness) mm	
	C/F Glass	MANTIX	69.73(W) x 153.16(H) x 0.15 (Thickness) mm	
	Upper Pol	SB	T4-0625TJ3A24(SAP17)69.63 x 152.51x 0.078 mm	
	Lower Pol	SB	TFT □□ /SB152.86×69.73×0.105/ □□□ 90°/ IN/ □□	
	UV Glue/Tuffy	HITACHI	F-4200EB-75	
	D-IC	Himax	HX83102-D01PPD1707-CP	
	ACF(COG)	HITACHI	ACF/□□ /AC-838B-14/L100m×W1.2	
	ACF(FOG)	HITACHI	ACF/AC-7813KM-25/0.8×100M	
	COG Ass'y	HLT	69.73(W)*155.66(H)*0.3(T)mm	
FPCA	FPC	HLT	40.41(W)*121.63(H)*0.13(T)mm	
	EMI coating	FB	HSF6000-2	
	Main Connector	Panasonic	SD_5055514020	
	LED lightbar CNT	-	-	
	Insulation Tape	FY	FY-JMGWJ05	
	Conductive Tape	FY	FY518	
	Release film on conductive tape	-	-	
	CNT Stiffener	HLS	SUS304 3/4H T=0.20mm	
	FPC Ass'y	HLT	FPC-HTF065H035-A2	
BLU	B/W tape	Sekisui	3806BHT=0.06mm	
	Upper Prism	Veitch	V-LN243Q4 T=0.096mm	
	Lower Prism	Veitch	V-LS242Q4 T=0.067mm	
	Diffuser Sheet	Changsong	CS189 T=0.055mm	
	LGP	Mitsubishi	TR1501A T=0.337mm	
	Reflector	3M	75W28 T=0.080mm	
	Mold frame	ALENG	SUS304 3/4H+PC5000A	
	LED	Suijing	SJ-S304ZW10(0.43T)	
	FPC Glue	Sekisui	3808BWH-D2 T=0.085mm	
	FPC	RCCT/Hayner Taixing	PI+ED copper	
	BLU Ass'y	HH	BLD-HTF065H035-A0	

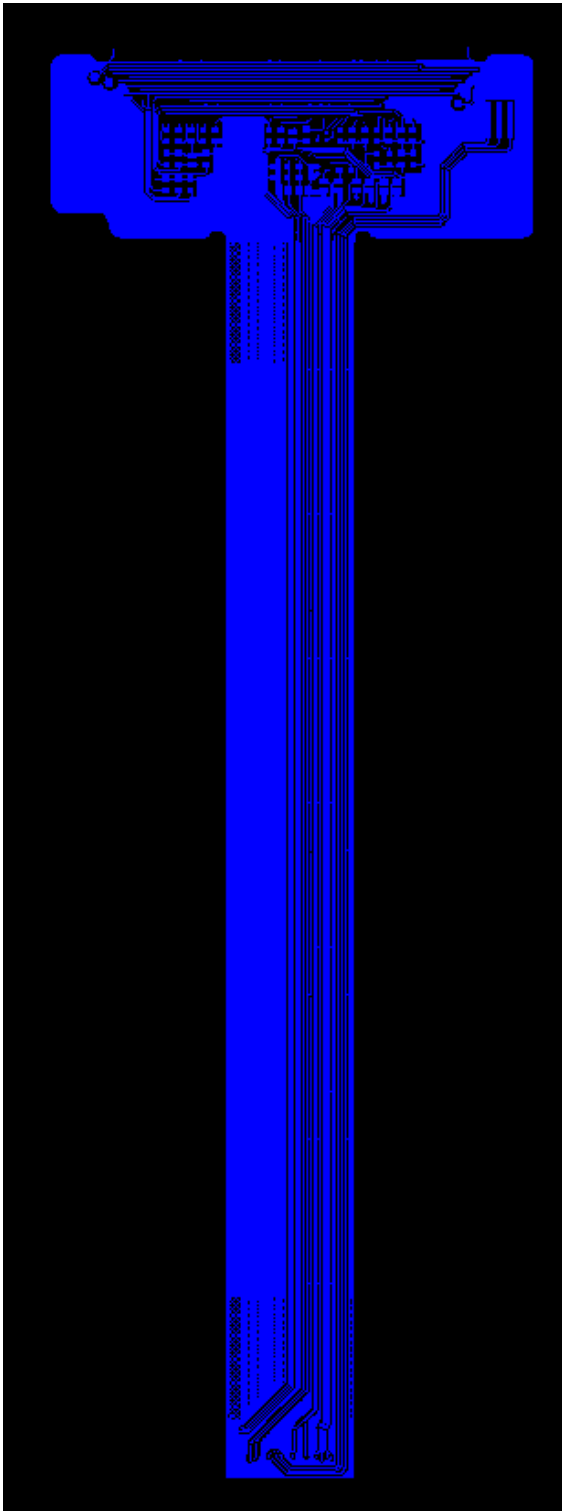
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### 1-3-1. FPCA Gerber/Layout and Schematic Diagram

Top



Bottom



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## 1-3-2. FPC Pin Assignment

257	GND
VCOM OPT	256
G1_TEST	255
VGLO	254
	253
	252
	251
VGLO	250
VGHO	249
	248
	247
	246
	245
	244
	243
	242
	241
	240
	239
	238
VSP	237
	236
NVREF	235
VSN	234
NVCCAREGT	233
	232
VCOM OPT	231
VCOM	230
VCOM OPT	229
VSN	228
	227
	226
	225
	224
	223
	222
NVREF	221
VCL	220
VGHO	219
	218
VSP	217
	216
VGH	215
	214
C21P	213
	212
C21N	211
	210
VSP	209
	208
VSN	207
	206
	205
C22P	204
	203
C22N	202
	201
VSP	200
	199
VDD3	198
	197
C41P	196
	195
C41N	194
	193
	192
	191
	190
	189
	188
VDD3	187
	186
IOVCC	185
	184
VDD3	183
	182
	181
	180
IOVCC	179
	178
HS_VCC	177
HS_LDO	176
	175
D2P	174
	173
D2N	172
	171
	170
D1P	169
	168
D1N	167
	166
	165
CP	164
	163
CN	162
	161
D0P	160
	159
D0N	158
	157
	156
D3P	155
	154
D3N	153
	152
	151
	150
HS_LDO	149
IOVCC	148
	147
VDD3	146
	145
IOVCC	144
	143
	142
	141
VSN	140
	139
VCOM	138
	137
	136
	135
	134
SCK	133
MCU	132
LEDPWM	131
MISO	130
CSN	129
	128
MCU_EN	127
TE	126
	125

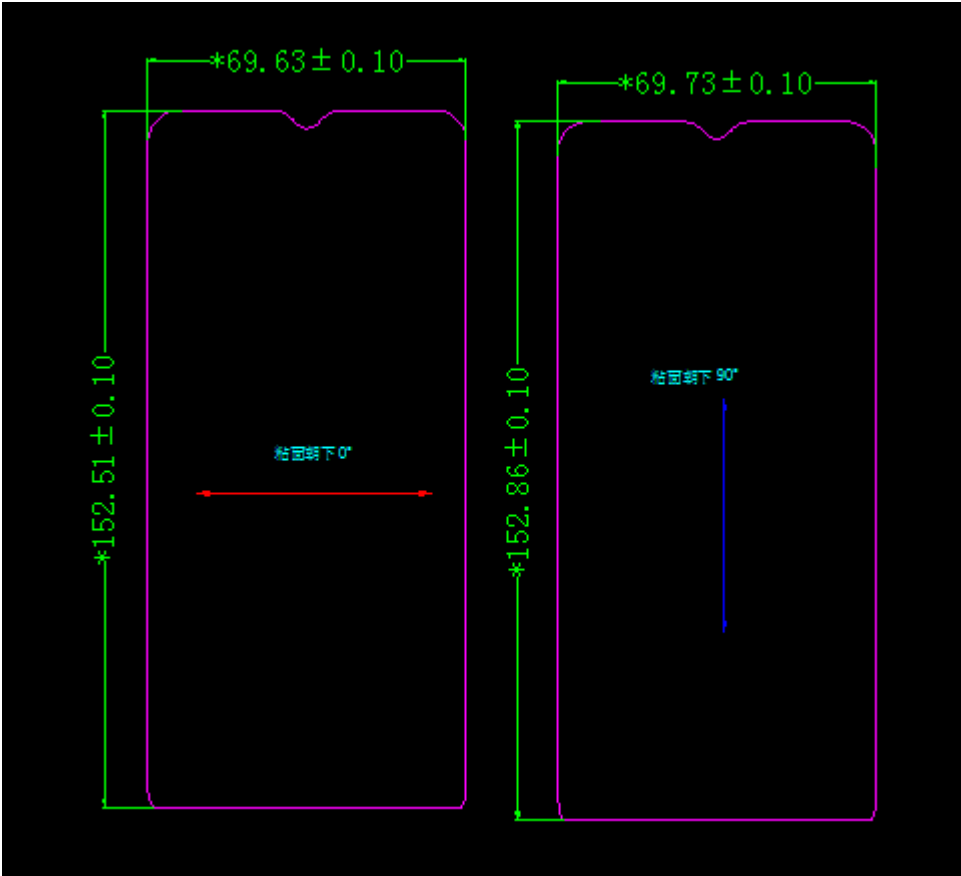
125	BIST_EN
124	BS[0]
123	BS[1]
122	PN5WAP
121	LANSSEL[0]
120	LANSSEL[1]
119	GPIO[5]
118	DUMMY
117	RESET
116	EXT_OSC
115	VDD1
114	VSSD
113	VDD1
112	GPIO[6]
111	GPIO[6]
110	GPIO[7]
109	GPIO[7]
108	DUMMY
107	FLASH_SPI_CS
106	FLASH_SPI_SCL
105	FLASH_SPI_MOSI
104	FLASH_SPI_MISO
103	FLASH_HOLD
102	FLASH_WP
101	TP_RST
100	TP_RST
99	TP_ICC_SCL
98	TP_ICC_SDA
97	INT
96	TSIX
95	VGSP
94	VGSN
93	VSSD
92	VDD3
91	VDD3
90	VDD1
89	VDD3
88	VDD3
87	VSP_G
86	VSP_G
85	VSSA_G
84	VSSA_G
83	VSN_G
82	VSN_G
81	VSSAC
80	VSSAC
79	VREF
78	VREF
77	VSPR
76	VSNR
75	VSNR
74	VDD3
73	VSSD
72	VSSD
71	VDD1
70	VDD1
69	VDD1
68	VCL
67	VCL
66	VSSA
65	VSSA
64	C42P
63	C42P
62	C42P
61	C42N
60	C42N
59	VSN
58	VSN
57	VSN
56	VSSD_P
55	VSP
54	C31P
53	C31P
52	C31N
51	C31N
50	VGL
49	VGL
48	VGLO
47	VGLO
46	VMD
45	VMD
44	VSP
43	VSP
42	VTSTOUTP
41	VTSTOUTP
40	VTSTOUTN
39	VTSTOUTN
38	DUMMY
37	VSSA
36	VSSA
35	VSN
34	VSN
33	VCOM_OPT_R
32	VCOM_OPT_R
31	VCOM
30	VCOM
29	VCOM_FB
28	VCOM_PASS_R
27	VSSD
26	NVCCAREGT
25	NVCCAREGT
24	NVCCAT
23	NVREF
22	VSP
21	VSP
20	VSSAT
19	VSSAT
18	VSSAT
17	LED[4]
16	LED[5]
15	LED[6]
14	LED[6]
13	SHK[4]
12	SHK[5]
11	SHK[6]
10	VGH1
9	VGH2
8	VGH2
7	AFE_TEST[2]
6	AFE_TEST[3]
5	VDD1
4	VSSD
3	G2_TEST
2	VCOM
1	GND

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1-3-3. Pol General Spec

UP POL

DOWN POL



1-4. Change List

	N o.	Reason	Change Details		Remarks
			Before	After	
H/W change	1				
	2				
	3				
Design Change	1				
S/W change	1	Improve gamma	The code is default	Change register of gamma	
	2				

- Remarks:
1. H/W change includes all materials, components, label etc.
  2. Design change includes size, position etc.
  3. S/W change includes initial code etc.

Please pay attention that this list is just a summary, an individual Design Change List which contain much more information is also needed

## 2-1. Absolute Maximum Ratings

The following are maximum values which, if exceeded, may cause faulty operation or damage to the unit.

**Table 2.1 Absolute Maximum Ratings**

Item	Symbol	Value		Unit	Notice
		Min	Max		
Power Supply Voltage 1	IOVCC	1.65	1.95	V	
Power Supply Voltage 2	VSP	4.5	5.7	V	
Power Supply Voltage 3	VSN	-4.5	-5.7	V	

Note1: The maximum applicable voltage on any pin with respect to 0V.  
Note2: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above.

### 3-1. ELECTRICAL CHARACTERISTICS

Table 3.1 Electrical Characteristics Of TFT-LCD Module

(AVDD=4.5V~6.6V, AVEE=-4.5V~-6.6V, VDDI=1.65V~3.6V, Ta=-30℃~70℃)

ITEM		SYMBOL	Min.	Typ.	Max.	UNIT	NOTE
Power Supply of I/O		VDDI	1.65	1.8	1.95	V	
Power Supply of Analog		AVDD	5.3	5.5	5.7	V	
Power Supply of Analog		AVEE	-5.3	-5.5	-5.7	V	
Logic High/Low Input Voltage	H Level	V <sub>IH</sub>	0.7*VDDI	-	VDDI	V	
	L Level	V <sub>IL</sub>	VSS	-	0.3*VDDI	V	
Logic High/Low Output Voltage	H Level	V <sub>OH</sub>	0.8*VDDI	-	VDDI	V	I <sub>OH</sub> =-1.0mA
	L Level	V <sub>OL</sub>	VSS	-	0.2*VDDI	V	I <sub>OL</sub> =+1.0mA
LCD power consumption		PLCD	-	120	130	mW	@White Pattern

Note: Recommend register setting is base on typical power setting

### 3-2. Logic Power Consumption

ITEM	SYMBOL	Min.	Typ.	Max.	UNIT	NOTE
LCD power consumption	PLCD	-	120	130	mW	@White Pattern

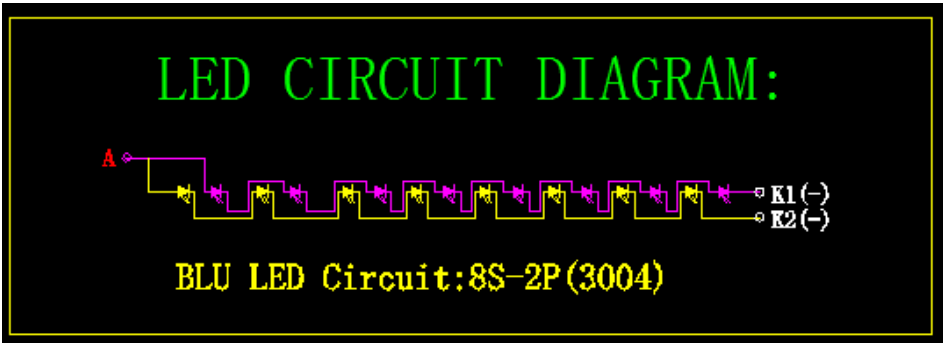
### 3-3. BACK LIGHT UNIT

3-3-1 The edge-lighting type of back light unit consists of 21 LEDs which is connected in serial.

Table 2-3-1 Electrical Characteristics Of Back Light Unit

Parameter	Symble	Conditions	Min	Typ	Max	Units	Note
LED forward Current	ILED	-	-	20	-	mA	
LED forward Voltage		ILED=20mA	2.8	3.0	3.2	V	
Power Consumption		IF=40mA	896	960	1024	mW	@2lane Without Driver IC

Number of LED: 16pcs, LED current: 20mA@1pcs  
Circuit of LED:



#### 3-3-2 LED Rank

- LED color piece □ UFZ single □ UFG+UEFmixed
- LED brightness grade □ 33&34 grade mixed



3-4. LCD INTERFACE CONNECTIONS

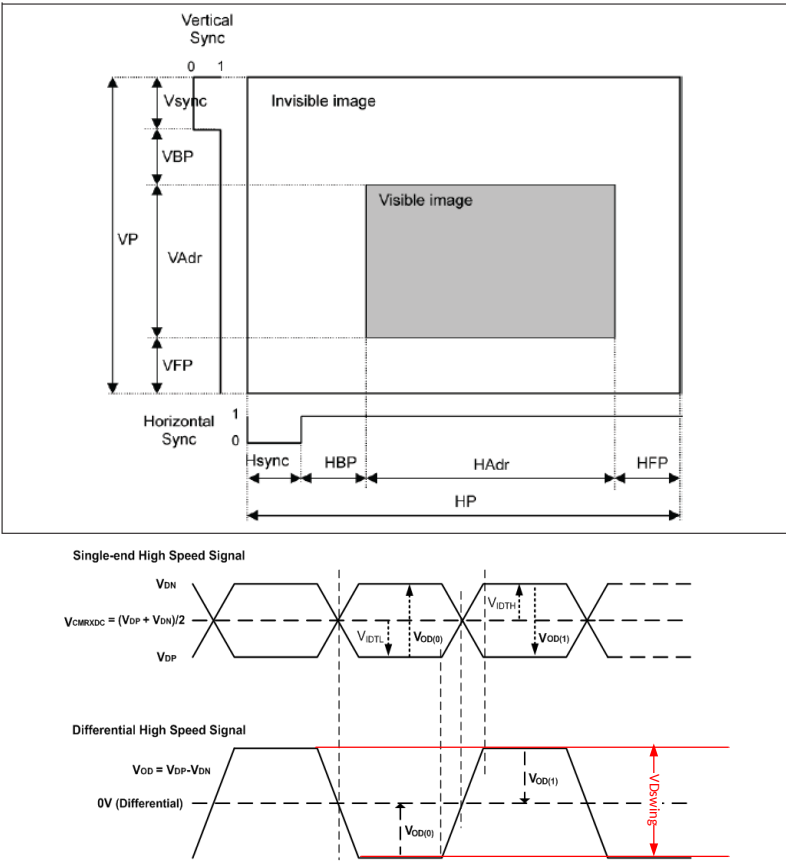
Connector: 5055514020    Table 3.4.1 LCD Connector Pin Configuration

PIN	SYMBOL	PIN	SYMBOL
1	GND	21	IOVCC
2	SCLK	22	RESET
3	SMOSI	23	TE
4	MISO	24	PWM
5	CS	25	GND
6	GND	26	D2_P
7	MCU_RESET	27	D2_N
8	I2C_SDA(NC)	28	GND
9	I2C_SCL(NC)	29	D1_P
10	T_INT	30	D1_N
11	NC	31	GND
12	NC	32	CLK_P
13	LED_C2	33	CLK_N
14	LED_C1	34	GND
15	LED_A	35	D0_P
16	NC	36	D0_N
17	NC	37	GND
18	VSN(-6V)	38	D3_P
19	VSP(6V)	39	D3_N
20	NC	40	GND

### 3-5. SIGNAL TIMING SPECIFICATIONS

ITEM			SYMBOL	Timing	UNIT
LCD	Frame Rate		-	60	Hz
Timing	DCLK	Frequency	fCLK	84	MHz
		Period	Tclk	11.90	ns
	Horizontal	Horizontal total time	tHP	775	t <sub>CLK</sub>
		Horizontal Active time	tHadr	720	t <sub>CLK</sub>
		Horizontal Pulse Width	tHsync	9	t <sub>CLK</sub>
		Horizontal Back Porch	tHBP	29	t <sub>CLK</sub>
		Horizontal Front Porch	tHFP	17	t <sub>CLK</sub>
	Vertical	Vertical total time	tvp	1800	t <sub>H</sub>
		Vertical Active time	tVadr	1600	t <sub>H</sub>
		Vertical Pulse Width	tVsync	2	t <sub>H</sub>
		Vertical Back Porch	tVBP	12	t <sub>H</sub>
		Vertical Front Porch	tVFP	186	t <sub>H</sub>
Differential Swing			VDswing	-	mV
Bit Rate			TX SPD(MBPS)	512	Mbps
Pixel Fomat				24(888)	Data bit/pixel
Lane				4	Lane

※Please refer to initial code

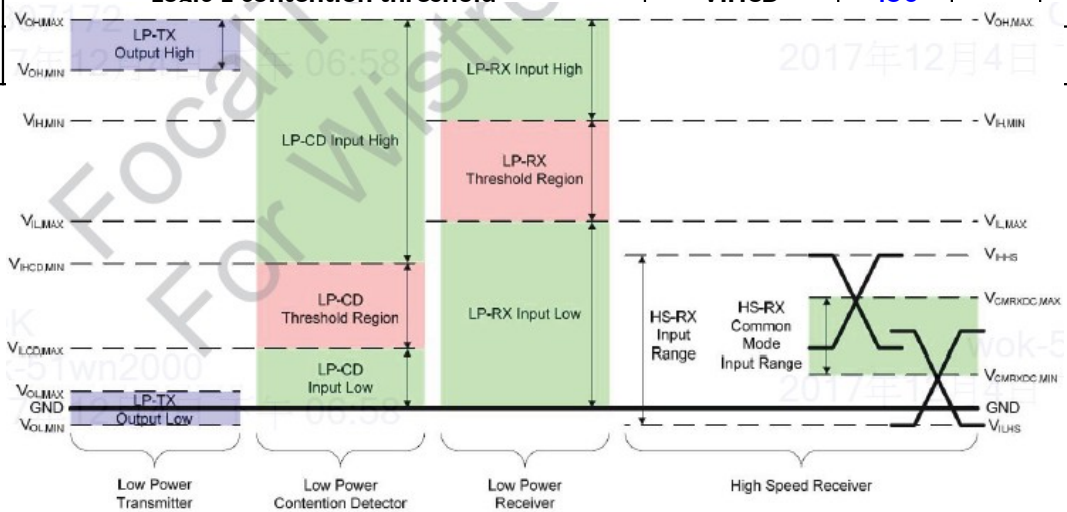


### 3-6. MIPI Data&CLK Line Impedance Test Result

#### (1) MIPI Interface Timing Sequence

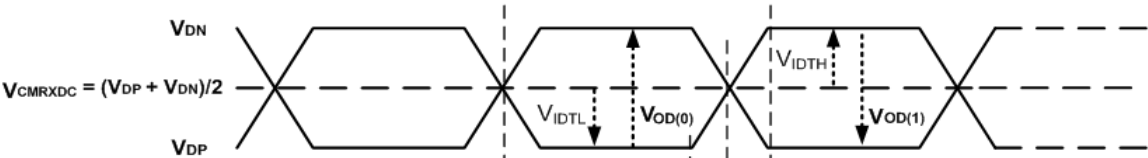
##### (a) MIPI interface DC characteristic □

Item		Parameter	Min.	Typ.	Max.	Unit
LP_T W	Thevenin output high level	VOH	1.1	1.2	1.3	V
	Thevenin output low level	VOL	-50	-	50	mV
	Output impedance of LP transmitter	ZOLP	110			ohm
HS_RX	Common-mode voltage HS receive mode	VCMRX(DC)	70	-	330	mV
	Differential input high threshold	VIDTH	□	□	70	mV
	Differential input low threshold	VIDTL	-70	□	□	mV
	Single-ended input high voltage	VIHHS	-	-	460	mV
	Single-ended input low voltage	VILHS	-40	-	-	mV
	Single-ended threshold for HS termination enable	VTERM-EN	□	□	450	mV
	Differential input impedance	ZID	80	100	125	Ω
LP_RX	Logic 1 input voltage	VIH	880	-	-	mV
	Logic 0 input voltage. not in ULPState	VIL	0	-	550	mV
	Input hysteresis	VHYST	25	-	-	mV
LP_CD	Logic 1 contention threshold	VIHCD	450	-	-	mV
					200	mV

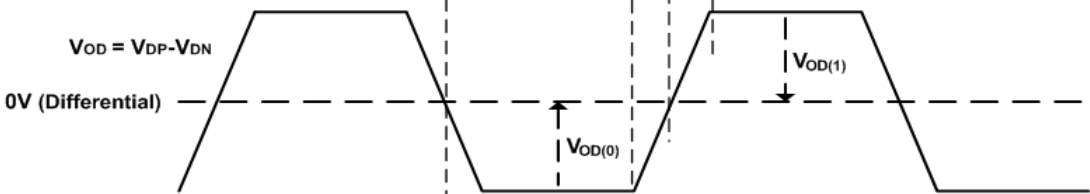


MIPI DC Diagram

Single-end High Speed Signal



Differential High Speed Signal



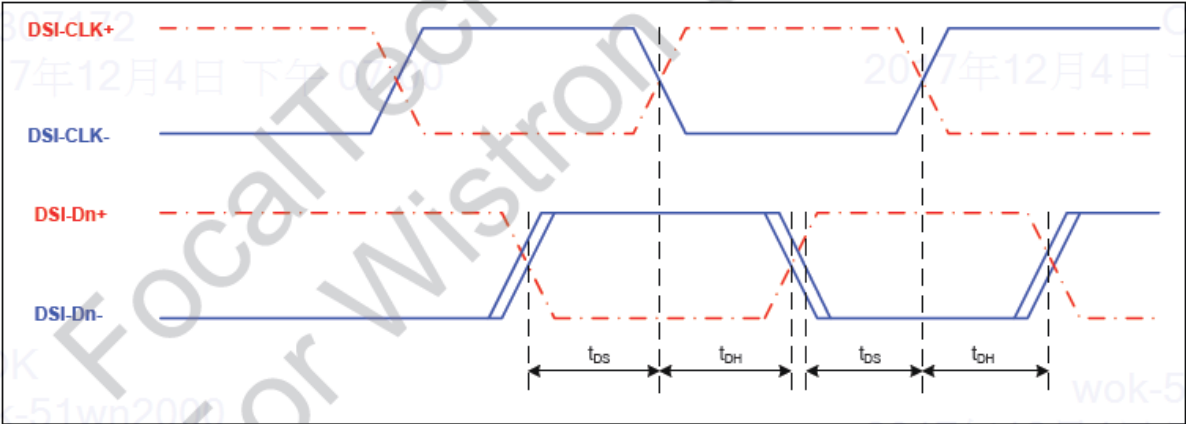
Signal-ended and Resulting Differential HS Signals Diagram

(b) MIPI data to clock timing definitions

Clock Parameter	Symbol	Min	Typ.	Max.	Unit
UI instantaneous	UI INST	-	-	12.5	ns
Data to Clock Setup Time [Receiver]	T SETUP[RX]	0.15	-	-	UI INST
Clock to Data Hold Time [Receiver]	T HOLD[RX]	0.15	-	-	UI INST

□ Note □

- \*1) This max value corresponds to a minimum 80 Mbps data rate per lane
- \*2) The minimum UI shall not be violated for any single bit period, i.e., any DDR half cycle within a data burst.
- \*3) Total silicon and package delay budget of 0.3 UIINST
- \*4) Total setup and hold window for receiver of 0.3\* UIINST
- \*5) T SETUP[RX] and T HOLD[RX] are only for RX without FPCB and connector and guaranteed by design.



MIPI data to clock timing definitions

## (2)TE

The Tearing Effect signal is described below:

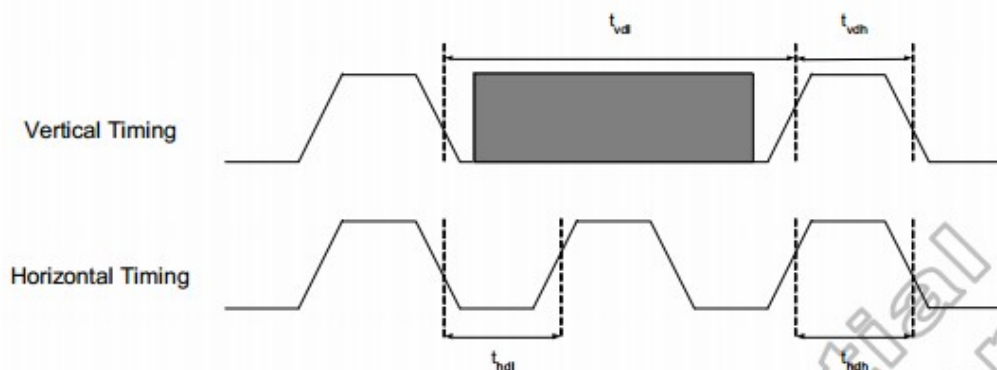


Figure 5.3: Tearing effect output line –tearing effect line timing

### Idle Mode Off

Parameter	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
Vertical timing low duration	tvdl	-	-	-	H
Vertical timing high duration	tvdh	2	-	-	H
Rise time	tr	-	-	15	ns
Fall time	tf	-	-	15	ns

Note: (1) The timings in Table 5.1 1 apply when MADCTL ML=0 and ML=1

Table 5.1: AC characteristics of tearing effect signal

The signal's rise and fall times ( $t_f$ ,  $t_r$ ) are stipulated to be equal to or less than 8.68ns.

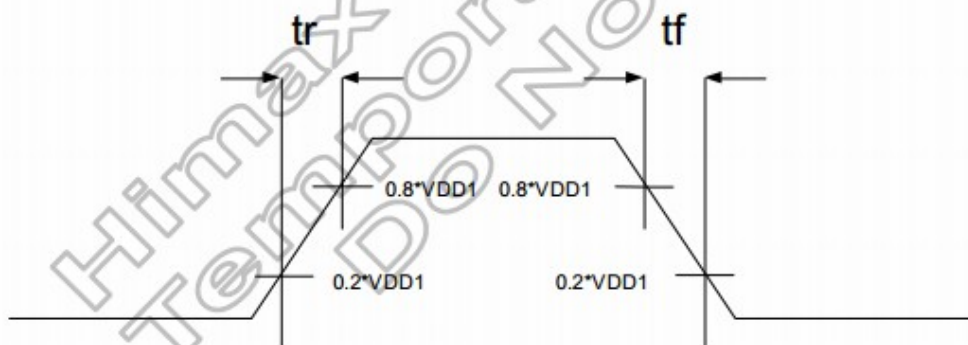
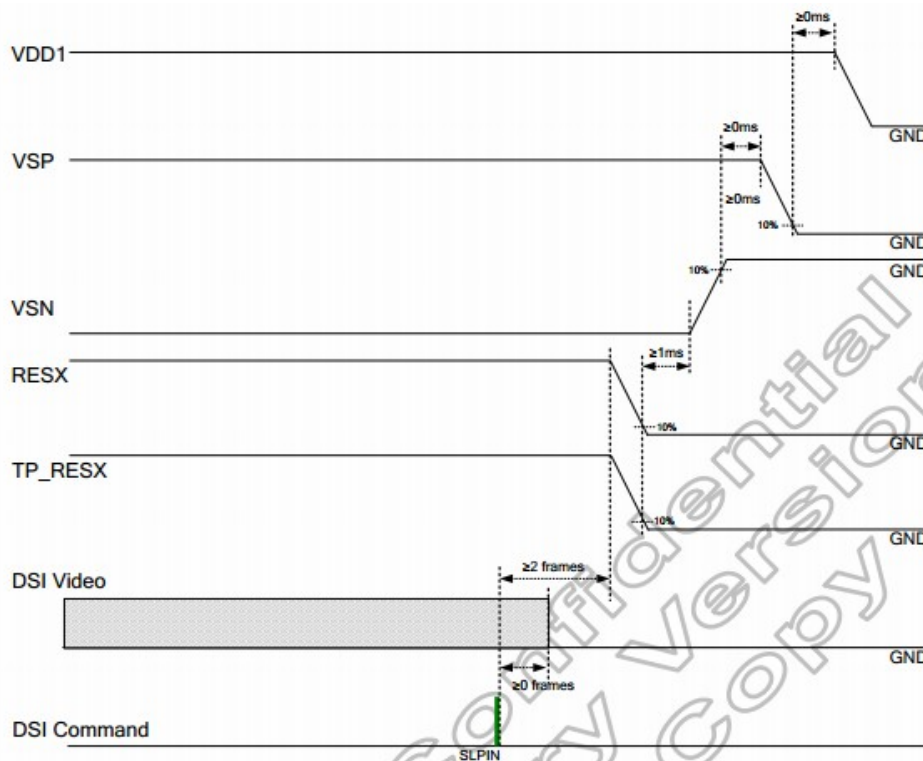
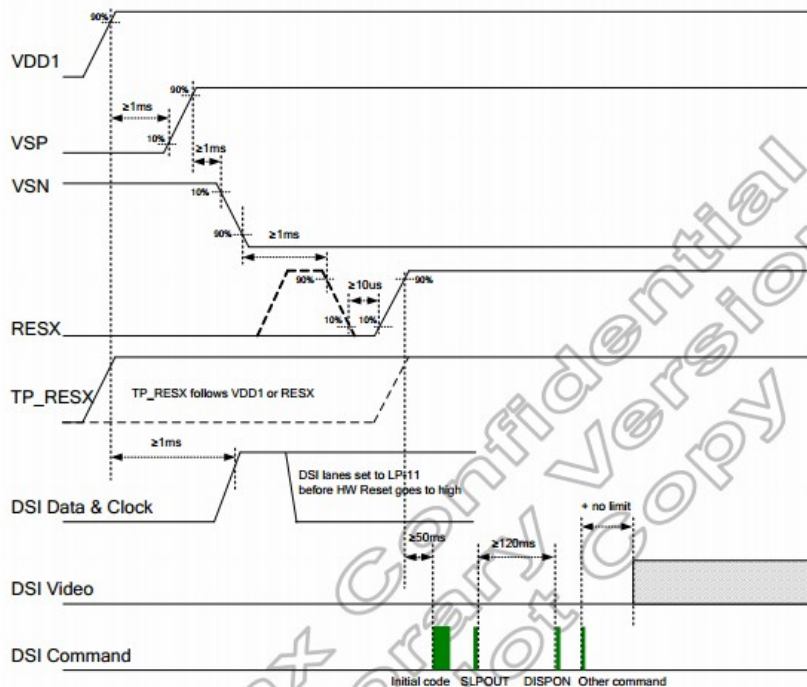


Figure 5.4: Tearing effect output line–definition of  $t_f$ ,  $t_r$

### 3-7. Power On/Off Sequence



3-8. Software Flow

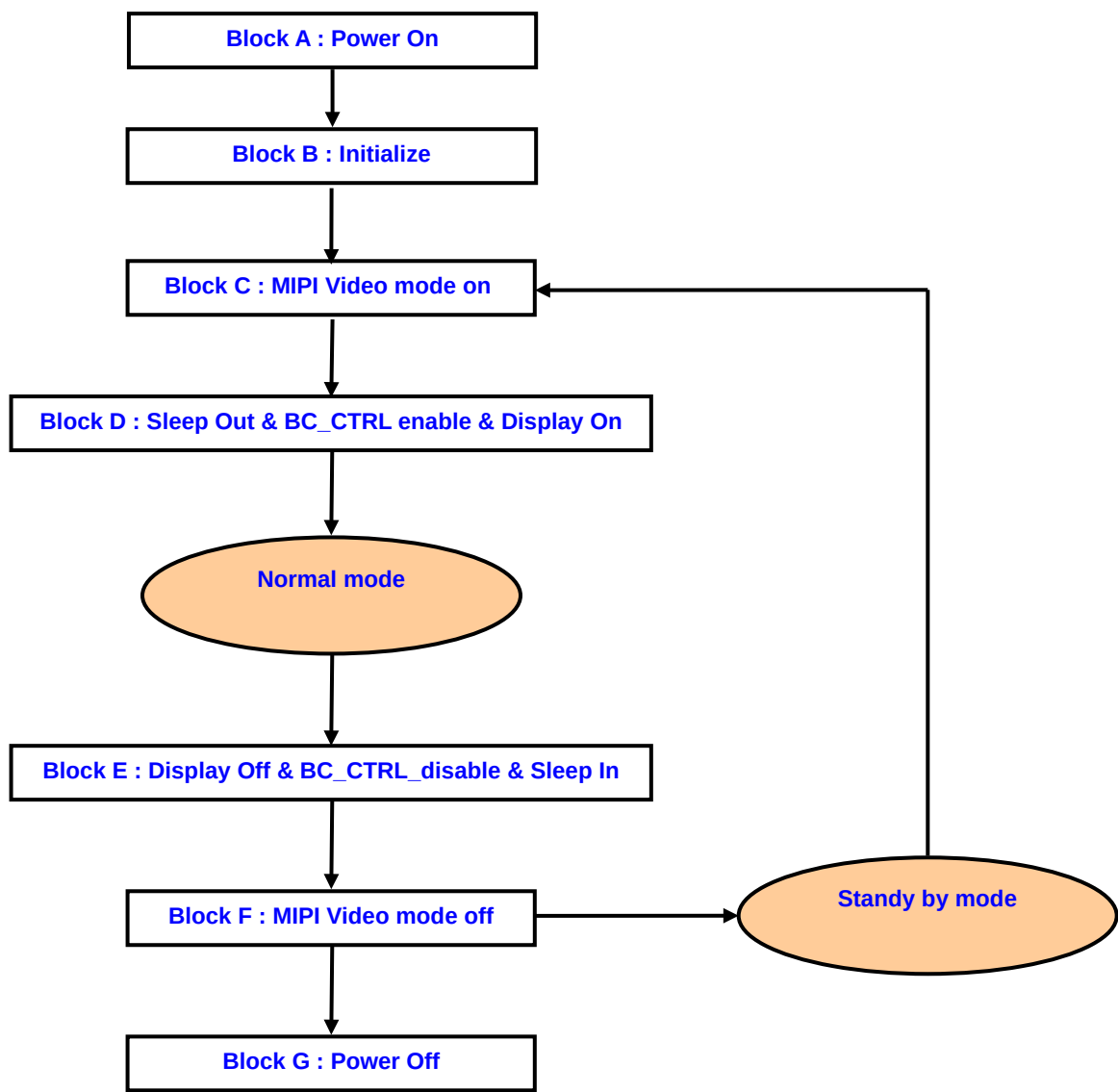



Fig 3.7 Software Flowchart

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### 3-9. Initial Code

```
/* Driver_RB9H_BK0 */
0x03, 0xB9,
0x83, 0x10, 0x2D,

/* Driver_RB1H_BK0 */
0x0B, 0xB1,
0x22, 0x44, 0x27, 0x27, 0x32, 0x52, 0x57, 0x39, 0x08, 0x08,
0x08,

/* Driver_RB2H_BK0 */
0x0E, 0xB2,
0x00, 0x00, 0x06, 0x40, 0x00, 0x0E, 0xAE, 0x38, 0x00, 0x00,
0x00, 0x00, 0xF4, 0xA0,

/* Driver_RB4H_BK0 */
0x0E, 0xB4,
0x01, 0x58, 0x01, 0x58, 0x01, 0x58, 0x03, 0x58, 0x03, 0xFF,
0x01, 0x20, 0x00, 0xFF,

/* Driver_RCCH_BK0 */
0x01, 0xCC,
0x02,

/* Driver_RD3H_BK0 */
0x19, 0xD3,
0x00, 0x00, 0x00, 0x00, 0x00, 0x10, 0x00, 0x17, 0x00, 0x63,
0x37, 0x0E, 0x0E, 0x00, 0x00, 0x32, 0x10, 0x08, 0x00, 0x08,
0x32, 0x16, 0x4E, 0x06, 0x4E,

/* Driver_RC9H_BK0 */
0x04, 0xC9,
0x04, 0x0C, 0xB2, 0x01,

/* Driver_RD5H_BK0 */
0x2C, 0xD5,
0x24, 0x25, 0x18, 0x18, 0x19, 0x19, 0x18, 0x18, 0x18, 0x18,
0x18, 0x18, 0x18, 0x18, 0x18, 0x18, 0x18, 0x06, 0x07,
0x04, 0x05, 0x18, 0x18, 0x18, 0x18, 0x02, 0x03, 0x00, 0x01,
0x20, 0x21, 0x18, 0x18, 0x18, 0x18, 0x18, 0x18, 0x18, 0x18,
0x18, 0x18, 0x18, 0x18,

/* Driver_RD6H_BK0 */
0x2E, 0xD6,
0x00, 0x09, 0x16, 0x1F, 0x28, 0x4B, 0x65, 0x6D, 0x74, 0x70,
0x89, 0x8D, 0x91, 0xA0, 0x9E, 0xA8, 0xB2, 0xC8, 0xC9, 0x65,
0x6D, 0x78, 0x7F, 0x00, 0x09, 0x16, 0x1F, 0x28, 0x4B, 0x65,
0x6D, 0x74, 0x70, 0x89, 0x8D, 0x91, 0xA0, 0x9E, 0xA8, 0xB2,
0xC8, 0xC9, 0x65, 0x6D, 0x78, 0x7F


/* Driver_RE0H_BK0 */
0x2C, 0xE0,

/* Driver_RE7H_BK0 */
0x04, 0xE7,
0xFF, 0x14, 0x00, 0x00,

0x01, 0xBD,
0x01,

/* Driver_RE7H_BK1 */
0x01, 0xE7,
0x01,
```



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```
0x01, 0xBD,
0x00,

0x01, 0xBD,
0x02,

/* Driver_RD8H_BK2 */
0x0C, 0xD8,
0xFF, 0xFF, 0xFF, 0xFF, 0xF0, 0xFF, 0xFF, 0xFF,
0xFF, 0xF0,

0x01, 0xBD,
0x03,

/* Driver_RD8H_BK3 */
0x18, 0xD8,
0xAA, 0xAA, 0xAA, 0xAA, 0xA0, 0xAA, 0xAA, 0xAA, 0xAA,
0xAA, 0xA0, 0xAA, 0xAA, 0xAA, 0xAA, 0xA0, 0xAA, 0xAA,
0xAA, 0xAA, 0xAA, 0xA0,

0x01, 0xBD,
0x00,

/* Driver_RBAH_BK0 */
0x13, 0xBA,
0x70, 0x23, 0xA8, 0x93, 0xB2, 0xC0, 0xC0, 0x01, 0x10, 0x00,
0x00, 0x00, 0x0D, 0x3D, 0x82, 0x77, 0x04, 0x01, 0x04,

0x01, 0xBD,
0x01,

/* Driver_RCBH_BK1 */
0x01, 0xCB,
0x01,

0x01, 0xBD,
0x00,

/* Driver_RCBH_BK0 */
0x05, 0xCB,
0x00, 0x53, 0x00, 0x02, 0x59,

/* Driver_RBFH_BK0 */
0x07, 0xBF,
0xFC, 0x00, 0x04, 0x9E, 0xF6, 0x00, 0x5D,

0x01, 0xBD,
0x02,

/* Driver_RB4H_BK2 */
0x08, 0xB4,
0x42, 0x00, 0x33, 0x00, 0x33, 0x88, 0xB3, 0x00,


0x01, 0xBD,
0x00,

/* Driver_RD1H_BK0 */
0x02, 0xD1,
0x20, 0x01,

0x01, 0xBD,
0x02,

/* Driver_RB1H_BK2 */
0x03, 0xB1,
0x7F, 0x03, 0xF5,

0x01, 0xBD,
0x00, );
);
```

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### 3-10. IC General Spec and Size

#### 3-10-1. IC General Description


Himax HX83102-D is an integrated chip of TFT display and “In-Cell” touch controller. It is designed to provide a single-chip solution that combines source driver control, gate driver control and power supply circuit.

HX83102-D supports MIPI DSI (Display Serial Interface) interface mode in TFT LCD driving.

Besides the display driving function, HX83102-D involves the capacitive touch screen control design with I2C interface. It supports touch screen of 576 sensing channels I/O. It also provides flexibility and selective functionality solution for the variety application of touch screen.

HX83102-D can be operated in low-voltage condition for the interface and integrated internal boosters that produce the liquid crystal voltage, breeder resistance and the voltage follower circuit for liquid crystal driver. In addition, It also supports various functions to reduce the power consumption of a LCD system via software control.

HX83102-D is suitable for any small portable battery-driven and long-term driving products, such as cellular phones, tablet and other mobile devices.

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### 3-10-2. Features

#### a. Display


- Single chip solution for TFT LCD display
- Resolution
  - Source resolution : 720, 640, 600 (pixels)
  - Gate resolution : NL, NL ≤ 1600. Typical resolution : 1280, 1440, 1600
- Display color modes
  - Full color mode
    - ◆ 16.7M colors: 24 bpp, 8R8G8B
  - Reduced color mode
    - ◆ 262K colors: 18 bpp, 6R6G6B
    - ◆ 65K colors: 16 bpp, 5R6G5B
    - ◆ 8 colors: 3 bpp (Idle mode)

#### b. Display module

- Support 2160 source channel outputs
- Gate driver control signals for GIP
- Supports 1-dot / 2-dot / 4-dot / Column/ Zig-Zag inversion
- Output voltage level
  - Positive source output voltage: VSPR to VGSP
  - Negative source output voltage: VSNR to VGSN
  - Positive gate driver output voltage: VGHO (regulated from VGH)
  - Negative gate driver output voltage: VGLO (regulated from VGL)
  - VCOM: 0V to -4.0V, 10mV/step
  - VSPR: 3.1V~6.2V
  - VGSP: 0V~0.7V
  - VSNR: -3.1V~-6.2V
  - VGSN: 0V~-0.7V
  - VGHO: 7.3V~20V
  - VGLO: -5.3V~-18V

#### c. Display control interface

- Display interface types supported
  - MIPI-DSI (Display Serial Interface) interface
    - ◆ Support DSI Version 1.1
    - ◆ Support D-PHY version 1.1

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d. Input power

- Logic and interface power (**VDD1**) voltage: 1.65V to 1.95V
- Positive power (**VSP**) voltage: 4.5V to 6.5V
- Negative power (**VSN**) voltage: -4.5V to -6.5V
- OTP programming power (**VPP**) voltage: 8.5V ± 0.25V

e. Touch controller features

- Projective touch screen control
- Maximum 576 channels
- Multi-touch
- Auto noise filter
- Customized function design (**Embedded 32bit MCU**)
- External flash
- I<sup>2</sup>C interface (**0x90 as default slave address**)


f. Miscellaneous

- Low power consumption
- GAS function when uncontrolled power off
- Temperature range: -40°C to +85°C
- On-chip OTP programming voltage generator
- OTP memory for initialization registers
  - 3 times MTP for VCOM and ID setting
- Image processing/enhancement
  - **CABC (Content Adaptive Brightness Control)**
  - **CE (Color Enhancement)**
  - **SLR (Sun Light Readability)**
  - Dynamic contrast enhancement
- **FRM (Free Running Mode)**
- Temperature sensor

3-11. Power Consumption

Test Pattern	Average VDDIO [mA]	Average VSP [mA]	Average VSN [mA]
Black	17.088	6.868	8.572
White	16.184	7.054	8.752
Red	17.61	6.954	8.654
Green	17.598	6.956	8.652
Blue	17.588	6.956	8.652
App Menu	20.092	9.622	11.406
Tizu Map	19.092	9.662	11.49
Green/Magenta Vertical Stripe	17.066	7.088	8.78
Black/White Vertical Stripe	17.458	6.99	8.734
Green/Magenta 1 Dot Checker	22.544	12.424	20.04
Black/White 1 Dot Checker	22.898	15.088	22.192
Sleep In Mode	3.35mA	124.1uA	14uA



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4. OPTICAL CHARACTERISTICS

4-1. Optical Characteristics – Backlight 100%

Item		Symbol	Rating			Unit	Definition □ Condition □	Remark
			Min.	Typ.	Max.			
Contrast (Center)		CR	800	1000	-	-	θ=0° Φ=0°	Note 1
Luminance of white ( w/ CG) (Center)		YL	380	450	-	cd/m²	IF=40mA	-
Uniformity (25P)		δ WHITE	80	85	-	%	IF=40mA	Note 2
Response time ( Rising + Falling )		TRT	-	30	35	ms	θ=0° Φ=0°	Note 3
NTSC		CG	65	70	-	%	θ=0° Φ=0°	CIE1931
Color chromaticity	White	Suv	0	-	0.31	-	θ=0° Φ=0°	D73: (u', v') = (0.1943, 0.4604)
		huv	0	-	360			
		Suv	0	-	0.25			
		huv	180	225	270			
	Red	Suv	3.26	3.36	3.46			
		huv	13.8	14.8	15.8			
	Green	Suv	1.49	1.59	1.69			
		huv	118	120	122			
	Blue	Suv	4.17	4.42	4.67			
huv		266.6	269.6	272.6				
Viewing angle	Hor.	θL	-	80	-	Deg.	CR≥10 At center	Note 4
		θR	-	80	-			
	Ver.	ΦT	-	80	-			
		ΦB	-	80	-			
Cross Talk		-	-	-	2	%	-	Note 5
Gamma		-	1.9	2.2	2.5	-	-	240 □□□ 2.2 ± 0.4
Flicker		-	-	-	-28	db	-	Note 6

4-2. Cell&BLU Optical Characteristics

Parameter	Typ	Unit	Remarks
Upper Pol Trans.	43	%	
Lower Pol Trans.	43	%	
Panel Trans.	3.85	%	
BLU Luminance	9200	Cd/m²	Center
BLU Luminance Uniformity	85	%	Note1,7

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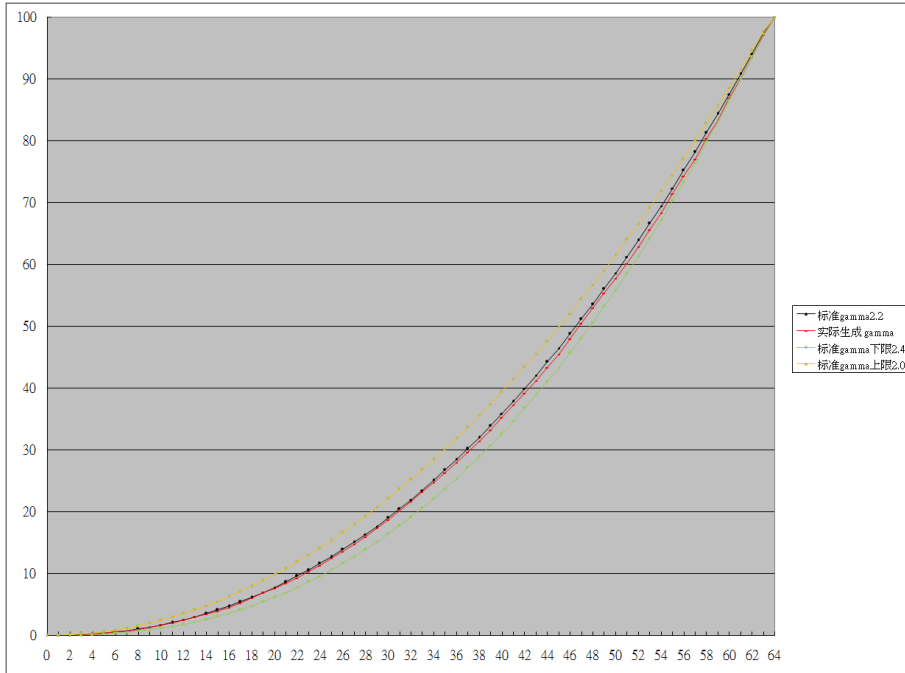
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## 4-3. Gamma/Color Coordinate Uniformity/CE Function/CABC Function

### 4.3-1 Gamma Curve



### 4.3-2 Color Coordinate Uniformity

Display Color (WHITE) @ 25 C				
NO	u'	v'	x	y
#1	0.1957	0.4667	0.3087	0.3271
#2	0.1949	0.4666	0.3076	0.3272
#3	0.1961	0.4672	0.3096	0.3278
#4	0.1947	0.4685	0.309	0.3303
#5	0.1953	0.4657	0.3073	0.3256
#6	0.196	0.4675	0.3098	0.3283
#7	0.1963	0.4715	0.3136	0.3248
#8	0.1951	0.4702	0.3109	0.323
#9	0.1966	0.469	0.3117	0.3286
#10	0.1939	0.4665	0.3062	0.3274
#11	0.1955	0.4683	0.3098	0.3297
#12	0.1958	0.4712	0.3107	0.3284
#13	0.1958	0.47	0.3107	0.3271
#14	0.1952	0.4697	0.3106	0.3301
#15	0.1964	0.4672	0.3099	0.3276
#16	0.1958	0.4665	0.3086	0.3267
#17	0.196	0.4659	0.3083	0.3258
#18	0.1956	0.4658	0.3077	0.3256
#19	0.1955	0.4653	0.3072	0.325
#20	0.1955	0.4665	0.3082	0.3269
#21	0.1962	0.4657	0.3083	0.3254
#22	0.1953	0.4693	0.3104	0.3304
#23	0.1942	0.4673	0.3072	0.3286
#24	0.1946	0.4673	0.3077	0.3284
#25	0.1947	0.4676	0.3081	0.3289
AVE	0.1955	0.4677	0.3091	0.3274
MIN	0.1939	0.4653	0.3062	0.3230
MAX	0.1966	0.4715	0.3136	0.3304

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### 4.3-3 CABG

Optical Machine			
UI Mode	Snow	Table	Firework
Target PWM %	100%	94.00%	90%
Sampe #1 PWM %	94.20%	88.90%	84.90%
Sampe #2 PWM %	94.20%	88.80%	84.70%
Sampe #3 PWM %	94.10%	88.80%	84.70%
Sampe #4 PWM %	94.10%	88.70%	84.80%
Sampe #5 PWM %	94.20%	88.80%	84.80%
Movie Mode	Snow	Table	Firework
Target PWM %	97%	85%	75%
Sampe #1 PWM %	91.50%	80.10%	70.50%
Sampe #2 PWM %	91.70%	79.80%	70.50%
Sampe #3 PWM %	91.70%	79.90%	70.50%
Sampe #4 PWM %	91.50%	80.10%	70.50%
Sampe #5 PWM %	91.70%	80.00%	70.50%

 Pattern List:  
Snow


Table



Firework



### CABC Measurement

This display has dynamic backlight control function to provide PWM feedback signal to external LED drivers to throttle LED currents in order to save power. This is an advanced function where the brightness of the backlight is automatically adjusted in accordance with the average picture level of the input image data by changing the PWM output.

The three specified images with CABC turned ON should give the following PWM feedback with a tolerance of +/-2%, not only in UI mode, but also movie mode.

- \* No noticeable brightness drop and bending should be seen when CABC is ON.
- \* If there's a significant number of pixels are on light gray/ white, PWM adjustment should not be very aggressive.




4-4. LCD Spectrum and BLU Spectrum

LCD

R	x	$\theta = \phi = 0^{\circ}$	(0.641)	(0.661)	(0.681)
	y		(0.301)	(0.321)	(0.341)
G	x		(0.217)	(0.237)	(0.257)
	y		(0.556)	(0.576)	(0.596)
B	x		(0.118)	(0.138)	(0.158)
	y		(0.088)	(0.108)	(0.128)

BLU

X	0.265	0.28	0.295
Y	0.24	0.255	0.27

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- Test Conditions
- Measurement should be executed in a stable, windless, and dark room.
  - Environment condition : Common air conditioner cleanness Ta=23±5℃ □ Humidity=60±15%
  - Distance: 50cm
  - Photo detector : BM-7A (Field 1°)

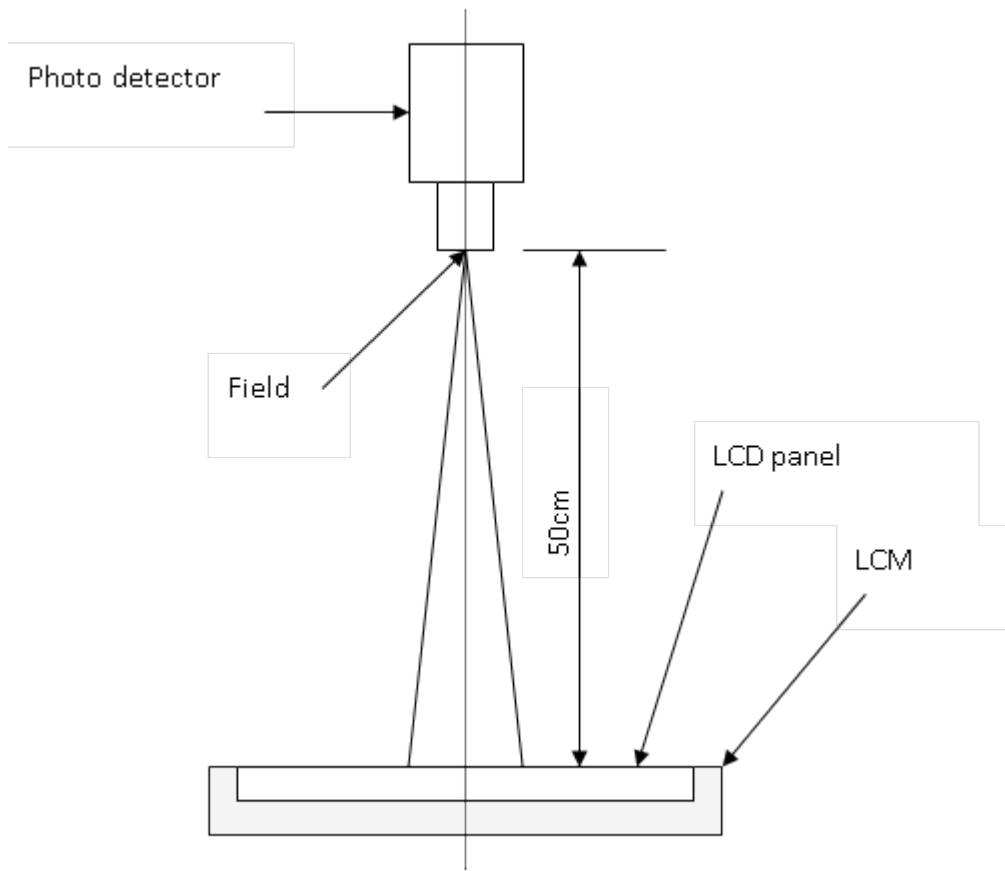



Fig 4.1. Optical Characteristic Measurement Equipment and Method

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Note 1: Definition of contrast ratio:  
CR = White Luminance (ON) / Black Luminance (OFF)

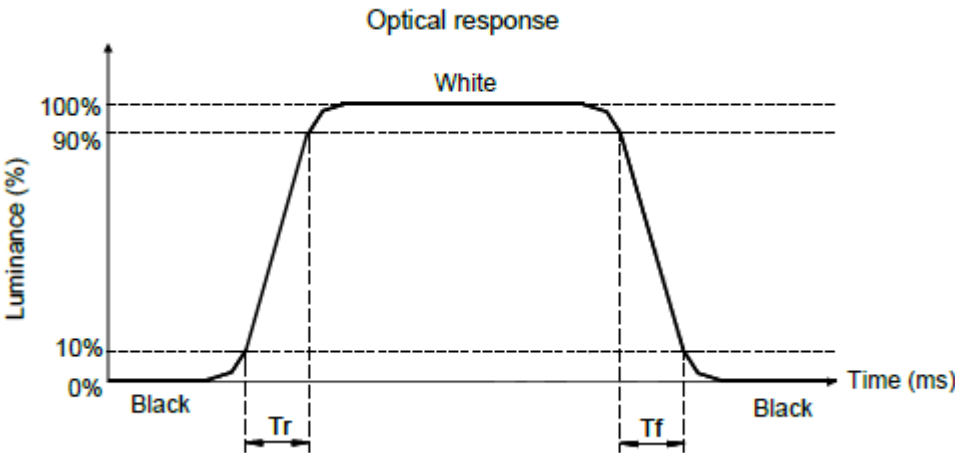
Note 2: δw = Minimum luminance of 25 point/Maximum luminance of 25 point


Uniformity Low Tier

To test for uniformity, the test area, which is 1/10 width and 1/10 height inside of the active area, is divided into 5(M) rows and 5(N) columns for the main display. The measurement spot is placed at the center of each box. 5 x 5 spots will be tested and the uniformity is calculated as the ratio of the maximum to minimum luminance. 2mm diameter spots will be tested

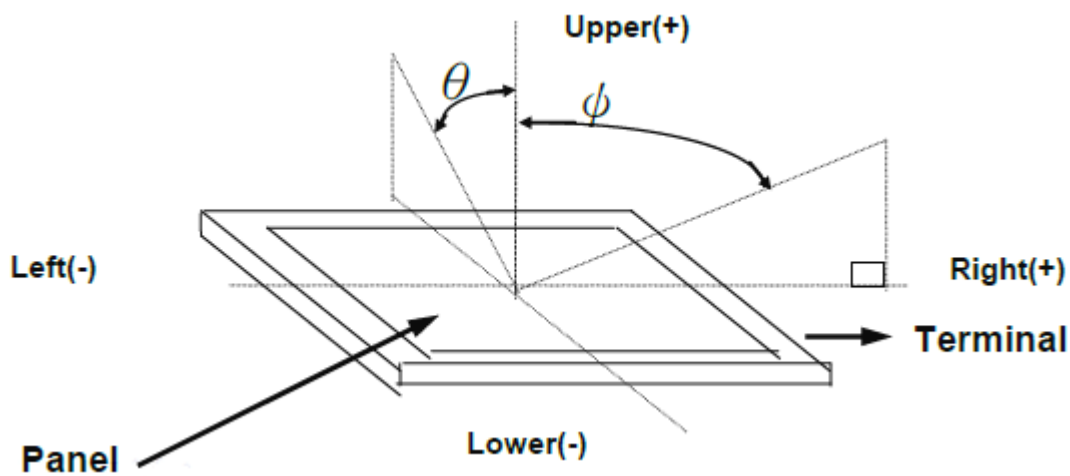
There should not be any visible hotspots, light streaking, Moire patterns, Newton rings and other visible artifacts.

Note 3: Definition of response time  
The output signals of photo detector are measured when the input signals are changed from “black” to “white” (rising time) and from “white” to “black” (falling time), respectively. Definition of response time □  
The response time is defined as the time interval between the 10% and 90% amplitudes.



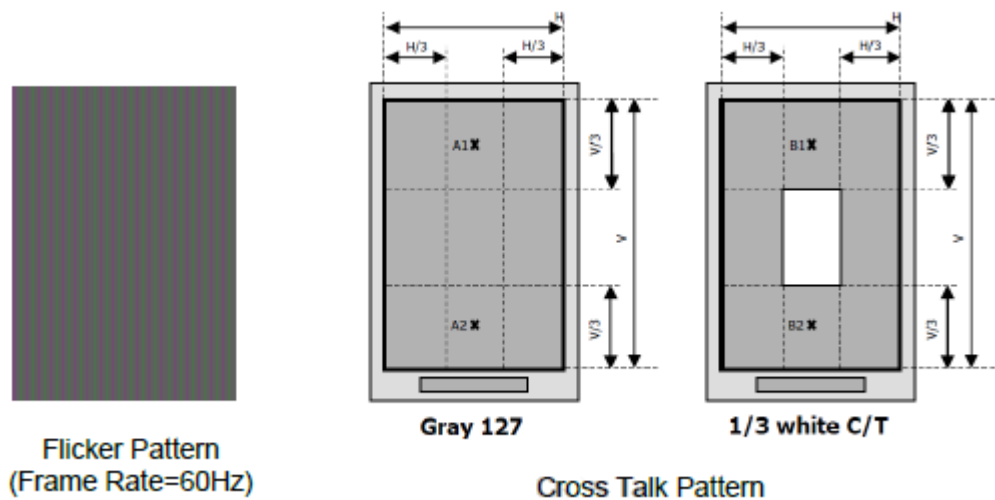
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Note 4: Definition of Viewing Angle ( $\theta$  □  $\Phi$ )



Note 5: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

Note 6:



## 5. MECHANICAL CHRACTERISTICS

The contents provide general mechanical characteristics for the model.  
In addition the figures in the next page are detailed mechanical drawing of the LCD.

Item		Min	Typ.	Max	Unit	Notice
LCD Module Size	Horizontal(H)	70.03	70.13	70.23	mm	Without FPC
	Vertical(V)	156.61	156.76	156.91	mm	
	Depth(D)	1.20	1.30	1.40	mm	
Touch Panel Size	Horizontal(H)	72.56	72.61	72.66	mm	
	Vertical(V)	161.73	161.78	161.83	mm	
	Depth(D)	0.65	0.7	0.75	mm	
LCM with CG Size	Depth(D)	2.0	2.15	2.3	mm	Without FPC
LCM with Cover Glass Weight		48.2	49.2	50.2	g	

TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □

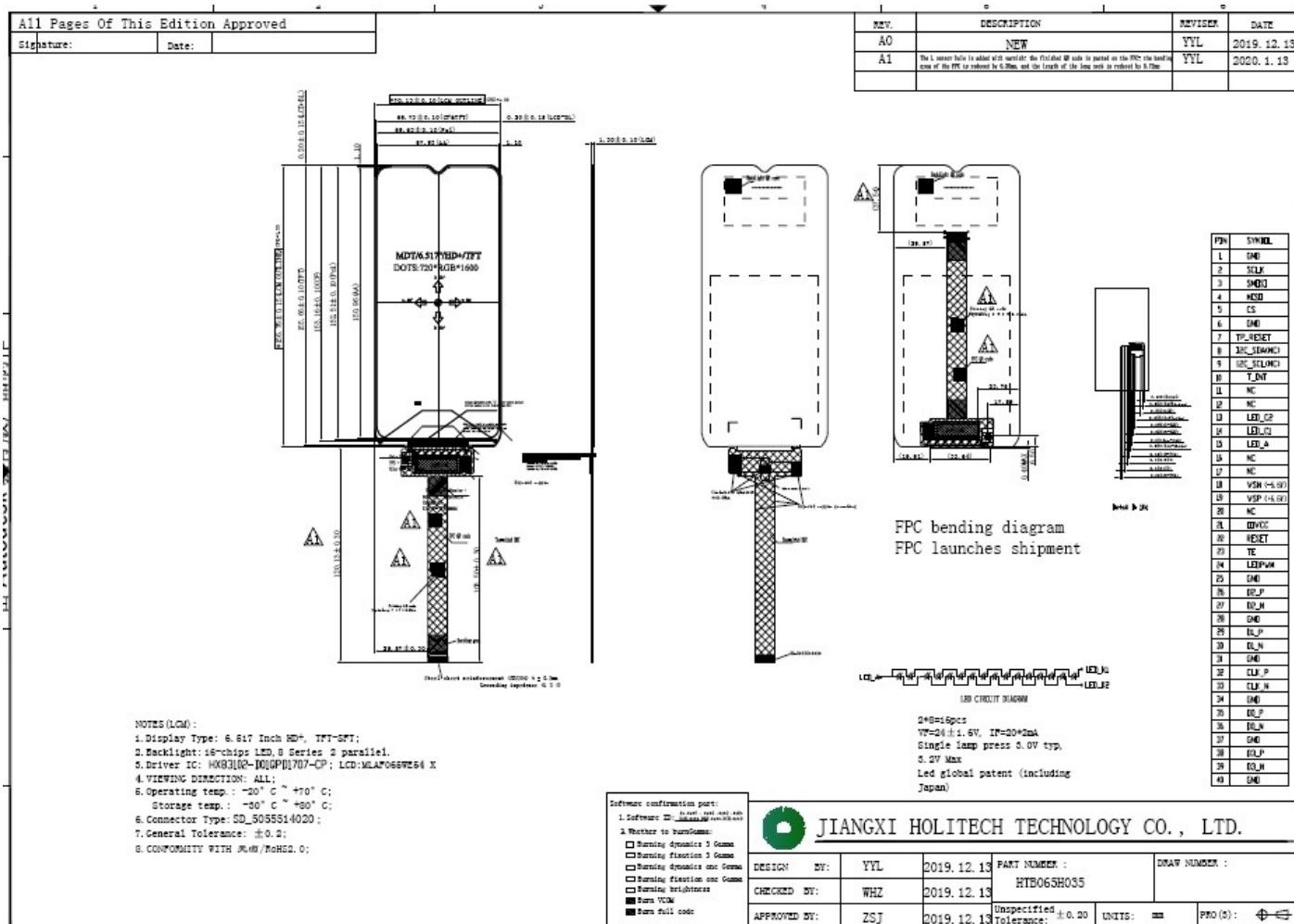
REVISION DATE: 4/7/2020

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## 5.1 LCM Drawing





TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □

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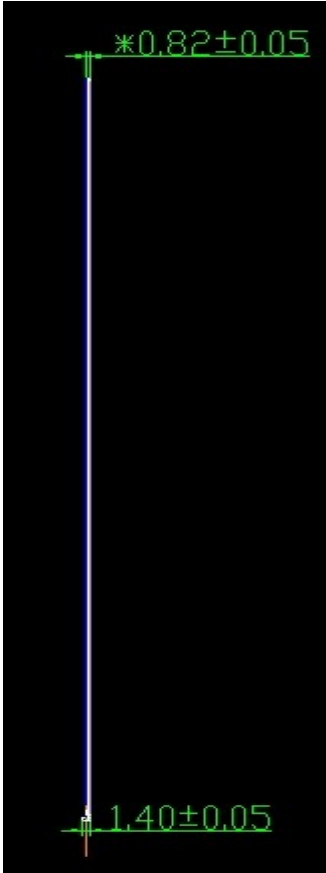
### 5.2-1 BLU Outline Dimension


[illegible]



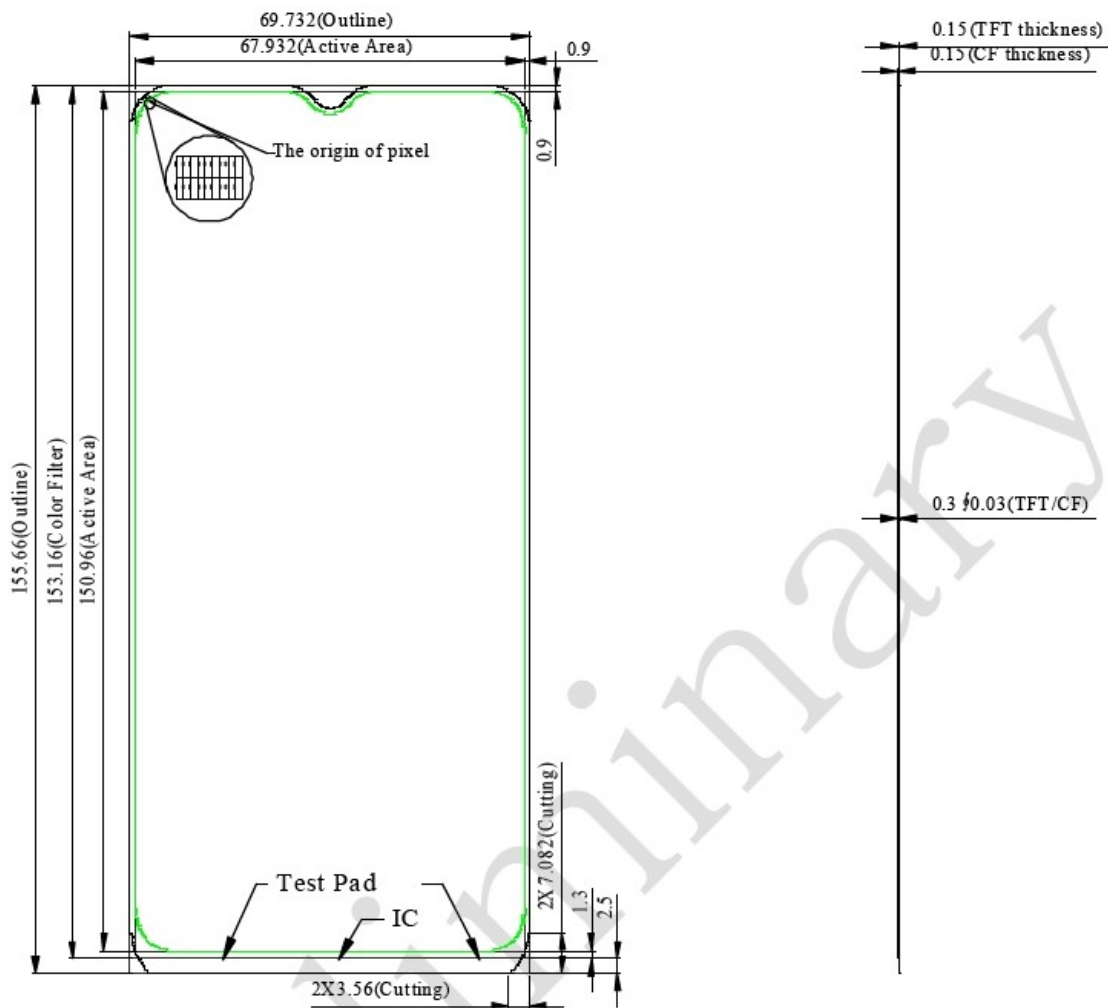
 motorola <small>a hewlett packard company</small>	Material or Methods Specification	NO. SD68C74145
TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □		
REVISION DATE: 4/7/2020	MEMO:	ISSUE: A
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5.2-2 BLU Section Review



 motorola <small>a hewlett packard company</small>	Material or Methods Specification	NO. SD68C74145
TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □		
REVISION DATE: 4/7/2020	MEMO:	ISSUE: A PAGE 42 / 56

### 5.3 Panel Outline Dimension



TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □

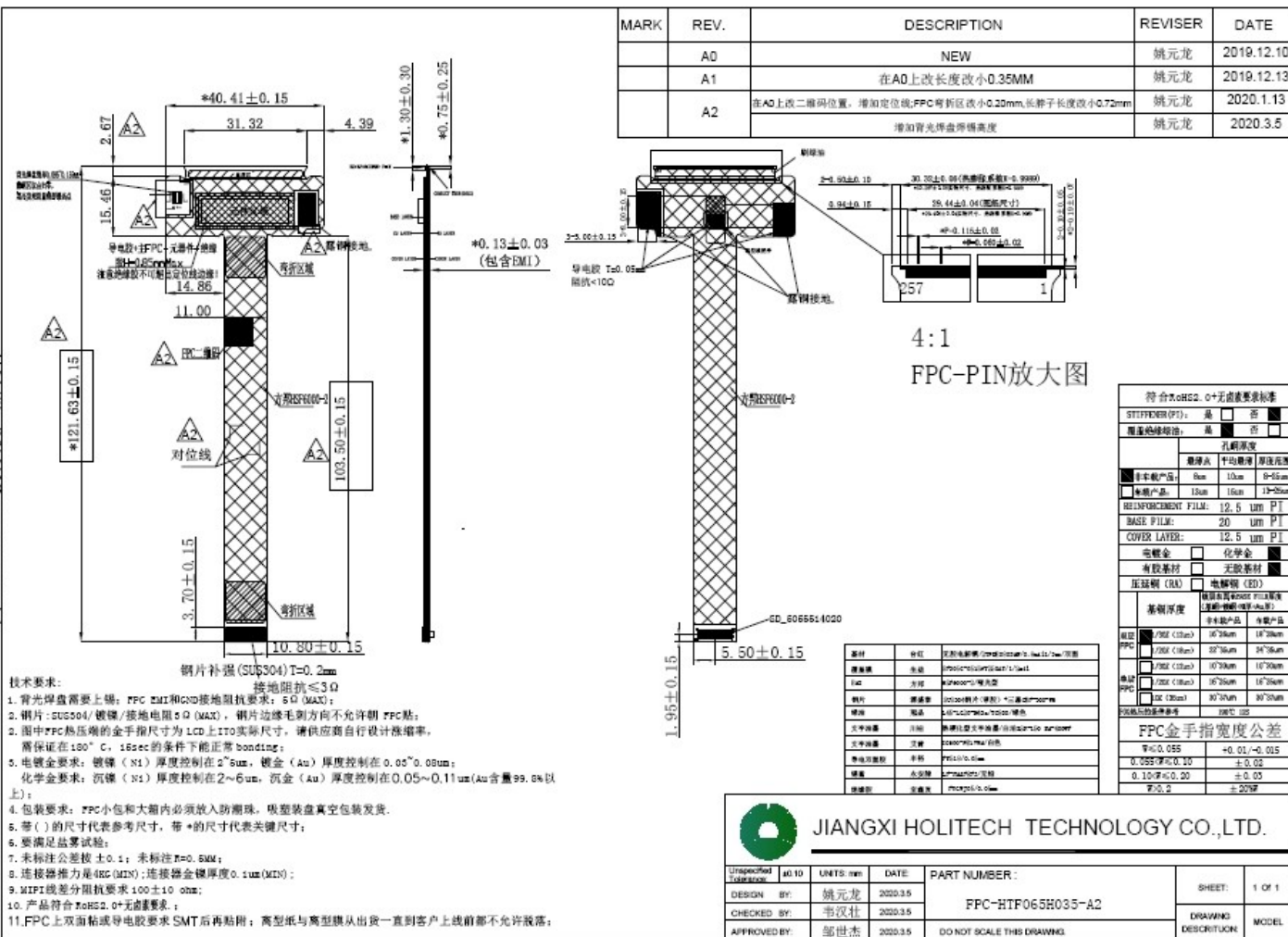
REVISION DATE: 4/7/2020


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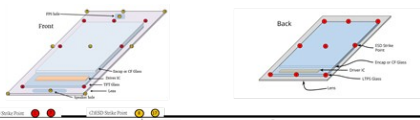

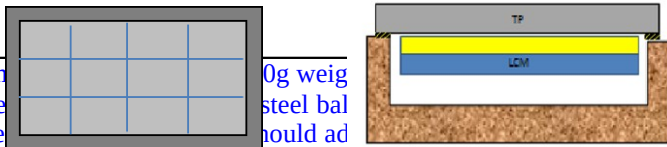
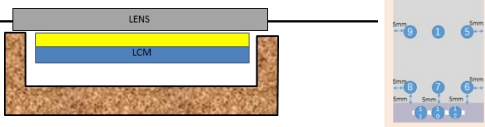
## 5.4 FPCA Outline Dimension



 motorola a freemove company	Material or Methods Specification	NO. SD68C74145
TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □		
REVISION DATE: 4/7/2020	MEMO:	ISSUE: A PAGE 44 / 56

6. RELIABILITY TEST

Test Items	Conditions
1. HTO	Temperature □ 70°C Sample Status □ operation Test time □ 240hr Room Temperature □ 2hr Measurement Point □ AA center point Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc) check electrical, visual, optical, touch
2. LTO	Temperature □ -20°C Sample Status □ operation Test time □ 240hr Room Temperature □ 2hr Measurement Point □ AA center point Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc) check electrical, visual, optical, touch
3. HTS	Temperature □ 80°C Test time □ 240hr Room Temperature □ 2hr Measurement Point □ AA center point Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc) check electrical, visual, optical, touch
4. LTS	Temperature □ -40°C Test time □ 240hr Room Temperature □ 2hr Measurement Point □ AA center point Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc) check electrical, visual, optical, touch
5. HTBO	Temperature □ 60°C Humidity □ 90% Sample Status □ operation Test time □ 240hr Room Temperature □ 2hr Measurement Point □ AA center point Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc) check electrical, visual, optical, touch
6. TST	Temperature □ -40°C~80°C Test time □ 30cycle = 60hr Room Temperature □ 2hr Measurement Point □ AA center point Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc) check electrical, visual, optical, touch
7. Cold Bubble	Temperature □ -20°C/-30°C Sample Status □ operation Test time □ 48hr/1hr Weight of iron ball □ 5.4g Diameter of iron ball □ φ11 Distance of drop □ 10cm Measurement Point □ AA center point Method □ First test: after storage 48hr at -20°C ,ball drop 5 times the same place in room temperature. Second test: after storage 1hr at -30°C ,ball drop 5 times the same place in room temperature. Judge □ No bubble

8. Touch Salt Spray	Method □ 3 cycles, each cycle including two stages □ 1).2 hours salt mist test □□ 15~35°C □ , □ 5±1 □□ Nacl 2).22 hours store □□ 40±2°C □ ,90% □ 95 □ RH After 3 cycles test, remain in normal temp and humidity □ record touch performance results after 2 hours and 24 hours separately Note: FPC connector and IC should be protect in the test." Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc)																																												
9.Touch UV Aging	Method □ 8 UVA340 lamps □ 50±3mm between lamp and sample center. put the sample face light source 8 cycles, each cycle including 2 stages □ 1.Expose in dark light,60±3°C environment for 8 hours. 2.Store in dark light,60±3°C environment for 4 hours □ spray water mist for 5 seconds □ Inspect if there is any abnormal change on the appearance Judge □ Appearance and performance should be OK(No crackle, color change, bubble etc)																																												
10.ESD	Test item □ <table border="1"><thead><tr><th rowspan="2">Strike Location</th><th rowspan="2">Display status</th><th rowspan="2">RC network</th><th colspan="2">Limit</th><th rowspan="2">Number of Strikes</th></tr><tr><th>Contact</th><th>Air</th></tr></thead><tbody><tr><td>Front on display</td><td>Display On</td><td>330Ω/150pF</td><td>±4 kV</td><td>±8 kV</td><td>5 per location</td></tr><tr><td>Ground on metal plane</td><td>Display On</td><td>330Ω/150pF</td><td>±4 kV</td><td>±8 kV</td><td>5 per location</td></tr><tr><td>Front, Back</td><td></td><td></td><td></td><td></td><td></td></tr><tr><td>Reset, Power, Ground on display flex</td><td>Display Off</td><td>1.5Ω/100pF</td><td>±2.5 kV</td><td>n/a</td><td>5 per location</td></tr><tr><td>Front on touch</td><td>Display On</td><td>330Ω/150pF</td><td>±8 kV</td><td>±15 kV</td><td>10 per location</td></tr><tr><td>Reset, Power, Ground on touch flex</td><td>Display Off</td><td>330Ω/150pF</td><td>±2 kV</td><td>n/a</td><td>5 per location</td></tr></tbody></table> Test position □ <div></div>	Strike Location	Display status	RC network	Limit		Number of Strikes	Contact	Air	Front on display	Display On	330Ω/150pF	±4 kV	±8 kV	5 per location	Ground on metal plane	Display On	330Ω/150pF	±4 kV	±8 kV	5 per location	Front, Back						Reset, Power, Ground on display flex	Display Off	1.5Ω/100pF	±2.5 kV	n/a	5 per location	Front on touch	Display On	330Ω/150pF	±8 kV	±15 kV	10 per location	Reset, Power, Ground on touch flex	Display Off	330Ω/150pF	±2 kV	n/a	5 per location
Strike Location	Display status				RC network	Limit		Number of Strikes																																					
		Contact	Air																																										
Front on display	Display On	330Ω/150pF	±4 kV	±8 kV	5 per location																																								
Ground on metal plane	Display On	330Ω/150pF	±4 kV	±8 kV	5 per location																																								
Front, Back																																													
Reset, Power, Ground on display flex	Display Off	1.5Ω/100pF	±2.5 kV	n/a	5 per location																																								
Front on touch	Display On	330Ω/150pF	±8 kV	±15 kV	10 per location																																								
Reset, Power, Ground on touch flex	Display Off	330Ω/150pF	±2 kV	n/a	5 per location																																								
11.FPC_Peel	speed = 1 to 2 mm/s □ 0degree □ □ Middle □ Right																																												
12.Yellow Spot Test	5mm/min □ 10mm diameter of spherical indenter □ 12 test points As is shown in figure, put the LCD & Lens assembling unit on Jig and backlight up. Check LCM display in white pattern with a mirror. It's not allowed yellow spot at any point of 12 test points under 400gf. The amount of liquid crystal of samples must be typ or USL in order to ensure the reliability of test. Each type of samples is 3 pieces. <div></div>																																												
13.Water Ripple Test	40mm □ 10mm diameter of spherical rubber □ 12 test points As is shown in figure, divided into 4 areas each area with 10mm diameter of indenter. Record the level of water ripple each point when testing. Check in 100 gray pattern. <div></div>																																												
14.Ball Drop	10cm □ 100g weight steel ball □ 10cm high, and 3 poin of driver IC, if □ Under there should add □ .No abnormal is allowed(no white spot within 45° view angle after 1min). <div></div>																																												

7. Safety & Environment Test Reports

Subject	Verification Test Result		Rev.
			Stage
			Date
	Contents	Judgment	Notes
Reliability	1. HTO	PASS	
	2. LTO	PASS	
	3. HTS	PASS	
	4. LTS	PASS	
	5. HTBO	PASS	
	6. TST	PASS	
	7.ALT	PASS	
	8. Cold Bubble	PASS	
	9. Touch Salt Spray	PASS	
	10.Touch UV Aging		
	11. Touch Ink Adhesive(OGS Only)		
	12.UVPP Film adhesion		
Conclusion			

## 8. Package

## 8.1. Packing Description

### (1) Packaging structure table

Material Science	Specifications	Consumption
Outer box	550*400*260/double pit K paper	1pcs
Inner box	380*265*100mm/single pit K paper	4pcs
Vacuum bag	500*460*0.07 mm/silver/antistatic	4pcs
Antistatic label	Label/15*15*0.05/Silver Dragon Material/Antistatic	4pcs
Foam board	530*380*20mm/white	2pcs
Pearl cotton	310*210*0.5mm/red/antistatic	40pcs
Plastic suction tray	PET Antistatic/Company Purchase	44pcs
Modular	3PCS*40 plates per plate	120pcs

## (2) Package method

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Signature:	Date:
------------	-------

MARK	REV.	DESCRIPTION	REVISER	DATE
	A0	NEW	yy1	2019.12.12

### 1. Packing pattern:

- Put the finished product back in the suction tray, TP is facing down.
- On a suction tray filled with products  
Add one pearl cotton and add another  
Add one product to the top layer  
Vacuum suction tray
- Vacuum a stacked bundle of products  
Vacuum in the bag and paste an anti-static label on the vacuum bag after vacuuming.
- Put a bundle of products into the vacuum bag into the inner box, and stick the barcode on the outer inner box

### 2. shipping label:

The label is the company's 375 special white label, and the sheet should be clean and readable.

Note that line 6 is "Company Name / Vacuum material No."

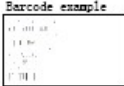
QCC part No.: H000000000

Vacuum material No.: 000000000

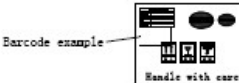
Item	Quantity
Outer box	1
Inner box	4
Vacuum bag	4
Antistatic label	4
Foam board	2
Panel cotton	40
Plastic suction bag	44
Modular	120

- Put 4 boxes of products in the outer box according to the arrangement of top, bottom, left and right.  
An anti-static foam board is padded on top and bottom of the outer box.
- Seal the box with adhesive paper, paste the shipping mark and barcode of the outer box

### 3. Outer Container Delivery Mark::




Material Science	Specifications	Consumption
Outer box	300x400x100mm/white plate & paper	1pcs
Inner box	300x400x100mm/white plate & paper	4pcs
Vacuum bag	300x400x100mm/white/antistatic	4pcs
Antistatic label	300x400x100mm/white/antistatic	4pcs
Foam board	300x400x100mm/white	2pcs
Panel cotton	300x400x100mm/red/antistatic	40pcs
Plastic suction bag	PE Antistatic/Conductive Protection	44pcs
Modular	300x400 plates per plate	120pcs




Barcode example

Handle with care




Barcode example

Handle with care



Barcode location



Barcode example

Handle with care

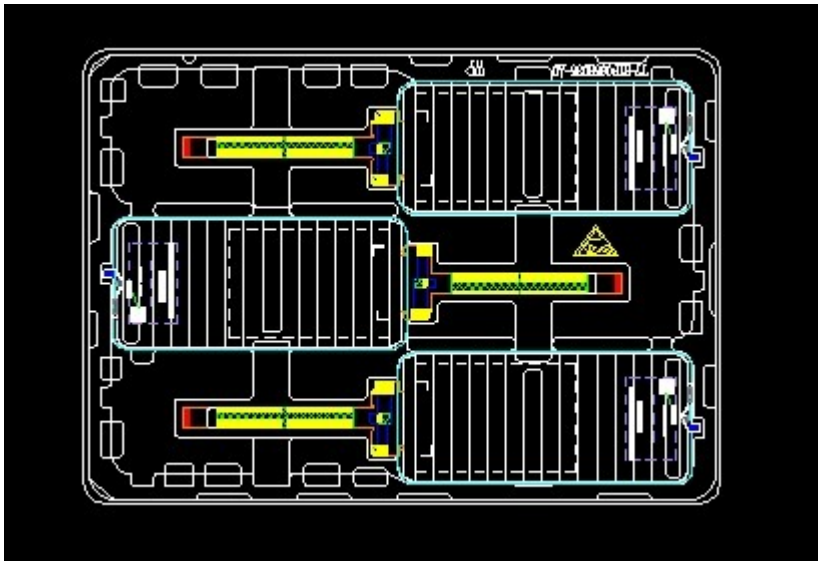
Unspecified Tolerance:

REVISION	BY:	DATE:
000001	yy1	2019.12.12
000002	whz	2019.12.12
000003	ZSJ	2019.12.12

**JIANGXI HOLITECH TECHNOLOGY CO., LTD. "**

UNSPECIFIED TOLERANCE:	UNITS: mm	DATE:	PART NUMBER :	PROJECTION	SHEET: 1 of 1
000001	yy1	2019.12.12	BZ-HTF065H035-A0	PROJECTION	MODEL:

(3) Tray diagram



8.2. Label Code

(1) Carton Label

Product packing list	
Model	
HLT Material Number	
Order number	
CNCE/Lenovo	60101022R001/SD68C74145
Number	
Packing Date	
Examination clerk	



TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □

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### (3) Wistron Product Label

Coding rule:

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Signature:	Date:	AD	NEW	姚元龙	2019.12.12

### HTF065H035二维码编码原则(53位)

8S Label 8S标签	Part Number 零件编号	Version 版本	Supplier Code 供应商代码	Supplier Site 供应商现场	Date Code 生产日期	Lot Code 批量代码	S/N 流水号
2位	12位	3位	7位	3位	4位	15位	7位
8S	%SD68C74145%	贴合图纸版本 (例A0版) -A0	4037064	我司是TFT2 L厂生产 —2	生产当天日期 例2019.2.20 192L	——HTF065H035	例51025 ——51025

8S%SD68C74145%贴合图纸版本4037064—2生产日期——HTF065H035流水号

带安全码:SD68C74145

月份:10—A 11—B 12—C  
日期对照表

01 - 1	11 - B	21 - M
02 - 2	12 - C	22 - N
03 - 3	13 - D	23 - P
04 - 4	14 - E	24 - R
05 - 5	15 - F	25 - S
06 - 6	16 - G	26 - T
07 - 7	17 - H	27 - V
08 - 8	18 - J	28 - W
09 - 9	19 - K	29 - X
10 - A	20 - L	30 - Y
31 - Z		

流水号说明:

1、共7位, 达不到7位时在数字前加“-”到7位, 如1, 对应就是——1, 如100, 对应就是——100。

2、流水号是独一无二的, 不可重复, 如首次生产100PCS, 流水号是1到100, 第二次生产也是100PCS, 流水号是101到200。

3、当位数超过7位, 达到10000000, 最前1位用字母表示, 流水号为A000000, 详见流水号对照表。


超过7位流水号对照表

10 - A	11 - B
12 - C	21 - M
13 - D	22 - N
14 - E	23 - P
15 - F	24 - R
16 - G	25 - S
17 - H	26 - T
18 - J	27 - V
19 - K	28 - W
20 - L	29 - X
31 - Z	30 - Y

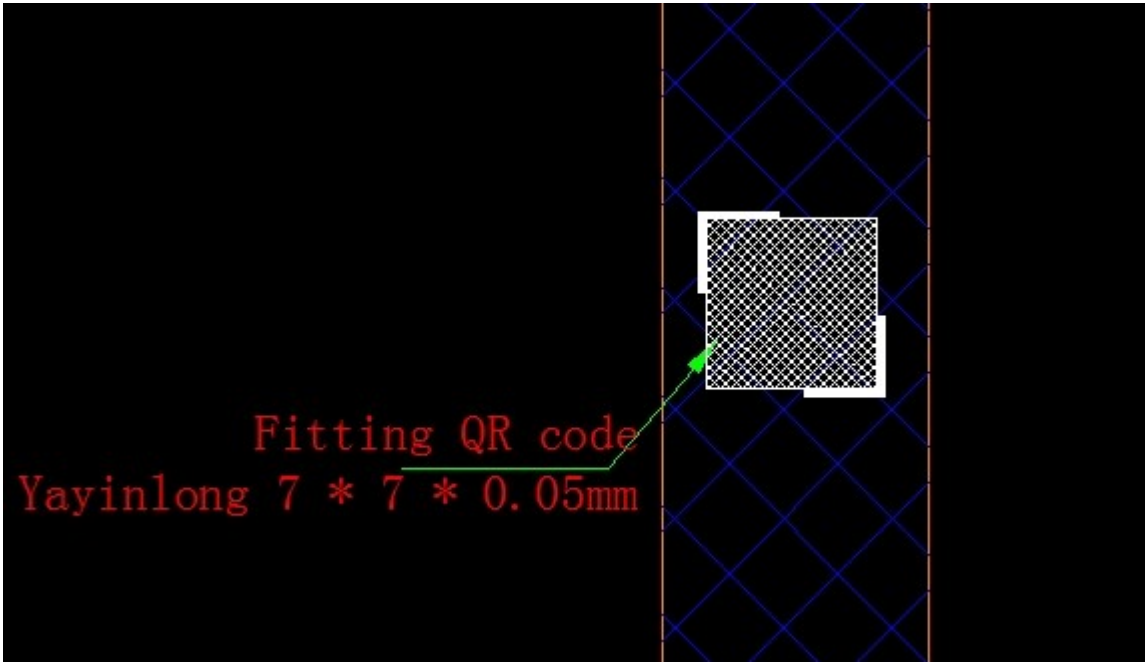



JIANGXI HOLITECH TECHNOLOGY CO., LTD.

DESIGN BY:	姚元龙	2019.12.12	PART NUMBER:	HTF065H035 二维码	DRAW NUMBER:
CHECKED BY:	李淑壮	2019.12.12			
APPROVED BY:	邹世杰	2019.12.12	Unspecified Tolerance: ±0.20	UNITS: mm	PAK(C):

 motorola <small>a hewlett packard company</small>	Material or Methods Specification	NO. SD68C74145
TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □		
REVISION DATE: 4/7/2020	MEMO:	ISSUE: A
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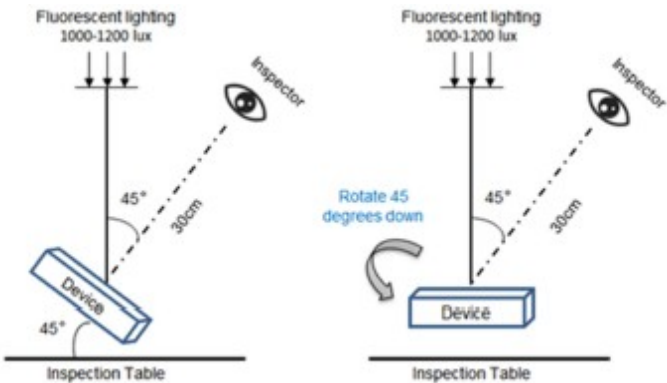
Size □ 7x7mm, Attached Location:



 motorola a hewlett packard company	Material or Methods Specification	NO. SD68C74145
TITLE: LCD MODULE, 72.61×161.78×2.15MM, MIPI,DISPLAY, ±5.5V,1.8V □ W18 Compliant □		
REVISION DATE: 4/7/2020	MEMO:	ISSUE: A PAGE 51 / 56

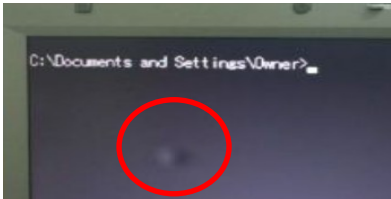

9. Incoming Inspection Standard

- 1.Inspection condition □ Electrical Inspection □
- A. Inspection Illumination □ 200±50LUX
- B. Light source: Cool white fluorescent □ 4230K □ ; distance from light source to the surface of parts not more than 100cm
- C. Viewing Distance □ 30cm
- D. Viewing angle □ the inspected surface of device should be put in 45° to table, the initial inspection angle is 90° or perpendicular to the surface, rotated around 45° to inspect all surfaces




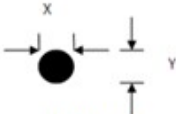

2. Electrical Inspection Item □□ W--Defect Width □ L--Defect Length □ DS--Defect Distance □ N--Defect Number □ D--diameter □

Inspection Item	Inspection Criterion	Number	Distance
Scratches	$W \leq 0.03\text{mm}$	Ignore	
	$0.03\text{mm} < W \leq 0.05\text{mm} \quad L \leq 2.0\text{mm}$	$N \leq 2$	$DS \geq 10\text{mm}$
	$0.03\text{mm} \quad W \leq 0.05\text{mm} \quad L \leq 3\text{mm}$	$N \leq 1$	
	No deep scratches that can be felt by finger		
Pinholes, Dots, Surface Particles	$D \leq 0.1\text{mm}$	Ignore	$DS \geq 1\text{mm}$
	$0.1\text{mm} \quad D \leq 0.15\text{mm}$	$N \leq 2$	$DS \geq 10\text{mm}$
	$0.15\text{mm} < D \leq 0.20\text{mm}$	$N \leq 1$	
Linear shape, Fiber	Display area $W \leq 0.05\text{mm} \quad L \leq 0.8\text{mm}$	$N \leq 1$	
Bright dot	R, G or B 1 dot	$N \leq 1$	
	Adjacent 2 dots	$N \leq 1$ (Vertical not allow)	
	Adjacent 3 dots	$N \leq 0$	
	Minimum distance	$DS \geq 10\text{mm}$	
	Density	$N \leq 0$	
	Total Qty	$N \leq 2$	
Dark dot	1 dot	$N \leq 2$	
	Adjacent 2 dots	$N \leq 1$ (Vertical not allow)	
	Adjacent 3 dots	$N \leq 0$	
	Minimum distance	$DS \geq 10\text{mm}$	
	Density	$N \leq 0$	
	Total Qty	$N \leq 3$	
Tiny Dot/Particle	Folløe the limit sample		
Bright Dot			
Light Leakage	Not Allowed		
Luminance □ Color difference	Follow spec		
Display abnormal	Not Allowed		
Image sticking	Not Allowed		
fuzzy display	Not Allowed		
Screen flash	Not Allowed		

Inspection Item	Inspection Criterion
Mura	Follow the ND Filter or the limit sample
water ripple	With the contact pen pressure display area, there shall be no water ripple <div>  </div>
Newton Ring	Under the condition of high temperature and high humidity, under the white pattern due to heating effect of the different layers in the LCD module lead to differ deformation. This phenomenon can be recover under normal environment. Fixed position ring cannot be accepted, the not fixed position for 3 seconds to disappear can be accepted. <div>  </div>

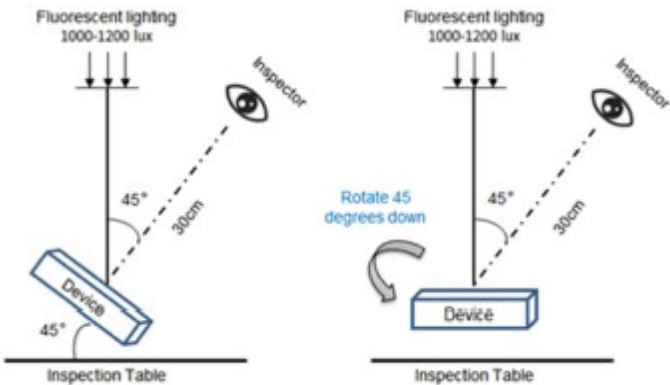
Note □

Mura	gap or uneven pressure in CF, TFT, LCD and LCM process. Mura could be vertical, horizontal, diagonal or patterned.
Bright dot	A dot is defined as a single sub-pixel (either red, green, or blue) within a pixel The definition of Bright pixels or dots: Pixel or dots that can be seen through the bare eyes of an operator under ambient light of 0 lux to 200±50 lux Bright dots shall be counted on a Black raster
Dark dot	A dot is defined as a single sub-pixel (either red, green, or blue) within a pixel Dark dots that can be seen with bare eyes, dark dots shall be counted on a 100% White raster, under ambient light of 0 lux to 200±50 lux
Dot clustering	There are many dots in the smaller area, refer to limit sample

缺陷定义			
	线状缺陷	点状缺陷 $D=X(X>Y)$ 或 $D=Y(X<Y)$	崩边，崩角，凸边

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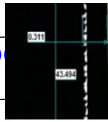
- 1.Inspection condition(visual inspection):
- A.Inspection Illumination: 1000~1200lux;
- B.Viewing Distance: 30cm
- C.Viewing angle: the inspected surface of device should be put in 45° to table, the initial inspection angle is 90° or perpendicular to the surface, rotated around 45° to inspect all surfaces
- D. B. Light source: Cool white fluorescent □ 4230K □ ; distance from light source to the surface of parts not more than 100cm

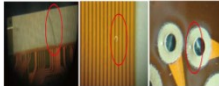




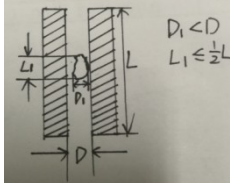

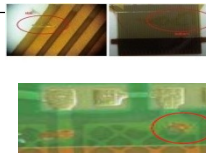
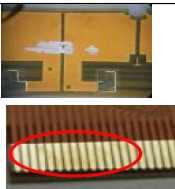
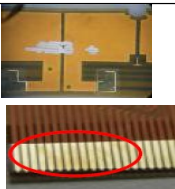



2.Area definition:

AA Area	Information display area only (Display window area, including the big screen window, small screen window and camera lens area (not including the camera deco, inactive area or border of the display ))
A Area	Front visible area. Primary surface exposed to direct closeup view in ordinary use. (Examples: positive viewable surface)

Area	Inspection Item	Inspection Criterion	Number	Distance
AA Area	Scratches	W≤0.03mm	Ignore	
		0.03mm □ W≤0.05mm □ L≤2mm	N≤2	DS≥10mm
		0.03mm □ W≤0.05mm □ L≤3mm	N≤1	
		No deep scratches that can be felt by finger		
	Pinholes, Dots, Surface Particles	D≤0.1mm	Ignore	DS≥1mm
		0.1mm □ D≤0.15mm	N≤2	DS≥10mm
		0.15mm<D≤0.20mm	N≤1	
	Linear shape, Fiber	Display area: W≤0.05mm □ L≤0.8mm Decorative area: W≤0.05mm, L≤1.0mm	N≤1	
	Screen Printing, Pad Printing, Laser Etching	Misalignment: From center point of artwork≤0.2mm		
		Missing or excess paint: D≤0.2mm □ DS □ 10mm	N≤2	
		Ghosting/Double print: Not Allowed		
		Missing Characters: Not Allowed		
	AF coating	Formation: Images are to be clean, crisp and smooth		
		Use oily pen drawing 3 cm line on the front, continuous for NG, discontinuous is OK		
	Other Item	Dirt □ Water/Oil marks □ Cracking □ Chipping □ Peeling □ Blistering □ Inclusions □ Bubbles □ Grid lines: Not Allowed		

Area	Inspection Item	Inspection Criterion		Number	Distance
A Area	Scratches	W≤0.03mm		Ignore	
		0.03mm □ W≤0.05mm □ L≤2mm		N≤2	DS≥10mm
		0.03mm □ W≤0.05mm □ L≤3mm		N≤1	
		No deep scratches that can be felt by finger			
	Linear shape, Fiber	W≤0.05mm □ L≤1.5mm		N≤2	DS≥10mm
	Pinholes, Dots, Surface Particles	Same Color	0.1mm □ D≤0.2mm	N≤2	DS≥10mm
		Defect	0.2mm □ D≤0.25mm	N≤1	
		Contrast	0.1mm □ D≤0.15mm	N≤2	DS≥10mm
		Color Defect	0.15mm □ D≤0.2mm	N≤1	
		D □ 0.1mm		Ignore	
	Color	Refer to Limit Samples if applicable			
	Stain	Color must be consistent and even throughout the part			
		Not Allowed			
	Screen Printing, Pad Printing, Laser Etching	Misalignment: From center point of artwork ≤0.2mm			
		Missing or excess ink: D≤0.2mm □ DS □ 10mm		N≤2	
		Ghosting: Not Allowed			
		Missing: Not Allowed			
		Double print: Not Allowed			
		Formation: Images are to be  crisp and smooth			
	Cover Glass edge chipping	D≤0.15mm, H≤T/2		N≤1	
CG outside edge Light Leakage	W<0.1mm		N :Ignore	DS ≥ 10mm	
	0.1mm ≤ W ≤ 0.2mm,L≤5mm		N ≤ 2	DS≥10mm	
	Out of the above range		Not Allowed		
CG inner edge Light Leakage	Not Allowed or judge by limit sample				
Ink Pinhole	D≤0.10mm		N≤4	DS≥15mm	
	D>0.1mm, or affect the appearance		Not Allowed		
	The defect inspection using reflected light, the black background check is not visible to ignore				
AF coating	Use oily pen drawing 3 cm line on the front, continuous for NG, discontinuous is OK				
Screen printing color difference	From the front visual no difference				
convex edge	Not Allowed				
Crack	Not Allowed				
Logo	Appearance refer to limit sample				
Photosensitive gole	Circular Defect D≤0.1mm Allow one □ but clustering points are not allowed □ Circular Defect D □ 0.1mm Not Allowed □ Other Defect is not allowed This part defects in black examine environment background to execution				
Camera Hole	Circular Defect D≤0.1mm Allow one □ but clustering points are not allowed □ Circular Defect D □ 0.1mm Not Allowed □ Other Defect is not allowed				
Light hole	Circular Defect D≤0.1mm Allow one □ but clustering points are not allowed □ Circular Defect D □ 0.1mm Not Allowed □ Other Defect is not allowed				
Other Item	Dirt □ Water/Oil marks □ Cracking □ Chipping □ Peeling □ Blistering: Not Allowed				
Back Area	Bubble	Ignore □ But don't allow to extend to AA			
	Ink Pimple	Circular Defect □ D≤3mm, Height H≤0.1mm		Ignore	
		Linear Defect □ L≤5mm, Height H≤0.1mm			
	CG Ink Surface energy (dyne value)	Use German factory 32 dyne pen draw a 1 cm line on the test surface, let stand for 30 seconds, observation line trace not retracted is OK			
Back Area	Stain	Ignore			
	Dirt can't be				

Area	Inspection Item	Inspection Criterion	Image
FPC Area	Folding/pressure/needle marks	1. Whether the FPC board face form acute Angle (dead), indentation is through the FPC bulge on the back of the back (whether white), conductor needle is less than 0.1 mm 2. Test whether the needle leakage nickel, copper 3. If there is a folding indentation coating area	
	Conductor scratch	Without protective film covering parts is the leakage of copper and nickel	
	flatness	Make up parts area part, inspection FPC Bonding area of ontology and steel reinforcement is a warp Bonding Area Arch warp≤2mm □ undulating warp≤1.5mm Steel reinforcement area warp≤1mm	
	residual copper	The conductor on the FPC line, because of the process or other factors produce the conductor residue in the conductor spacing, residual conductor scope of general line insulation degree decline, produce insulation fault phenomenon. $L1 \leq 2 S 1, A1 \leq 1 / 2 S 1$ $L2 \leq 2 S 2, A2 \leq 1 / 2 S 2$	 
	foreign matter	Bonding Area □ Foreign body with gold finger surface Gold finger between foreign card specifications $D1 < D$ & $L1 \leq \frac{1}{2} L$	
		No Bonding Area □ Electrical conductivity foreign bodies by the residual copper standard Of non-conductive foreign bodies across the third line, is not acceptable The electrical conductivity foreign body massive foreign body≤1mm→OK The electrical conductivity foreign matter filamentous foreign matter≤2mm→OK	
	Glue/surface dirt	Whether there is residual glue/conductor surface dirt	
	Air bubbles	(1) whether the protective film of bubble across the two wires (2) whether the edge of bubbles	
	Lack of ink	Whether the conductor naked	
	Printed word	1. Whether writing visual identification 2. The word out Text is offset to the PAD printing 3. Whether or not bearing the text	
	Plating color / oxidation	1. Tin lead change color: tin lead the sunburned or green 2. Gold-plated color: whether apparently gold-plated erythema, fingerprint	
<div> <div> <div>Parts missing / Over parts</div> <div>Whether the size is correct</div> <div>The key size</div> </div> <div> <div>Motorola Mobility Confidential Restricted - Do Not Redistribute</div> <div>Information contained on pages of this document cannot be reproduced or used in whole or in part without Motorola's written consent. Printed copies of this document are not controlled.</div> <div>Motorola Mobility Confidential Restricted - Do Not Redistribute</div> </div> </div>			
		Key size measurement	Must be within dimensional tolerance



10. Checklist

	Description	Request	Value
Connection	MIPI Impedance	100±10Ω	Yes
	B2B CNT	FR4, 0.3mm	SUS304, 0.2mm
	ID Pin	1 <sup>st</sup> source: GND 2 <sup>nd</sup> source: 1.8V(different cell) 2 <sup>nd</sup> source: GND(same cell+IC)	A1:0x0f , 0x04 ,0x02 ,0x91 DAH:0x00,DBH:0x00, DCH:0x13
IC	Protection	Shielding tape on IC	NO
FPC	Bending Area	Not exceed M/F	YES
	FPC status	Unfolded while direct bonding	YES
	GND Area	Need GND area to connect SUS	YES
	Test Points	Need shieling tape on it	YES
	Bending Area	Single layer	Single layer
SUS	4 Corner side	At lease 1.2mm	Yes
Panel	Glass Generation	G5?G6?	G6
	Cutting Q'ty	panel Q'ty each mother glass	-
	Display mode	VA/IPS	ADS
	Mask Q'ty	Array mask	7
	Pixel Domain	1 or 2?	1 Pixel 1 Domain
	ITO@C/F	ITO square resistance, thickness	≤ 5kΩ/□ ,≤ 200Å
	Scan direction	Single scan or dual scan	dual scan
	PS Parameter	Main/Sub PS density and size	MPS=9um Density=0.072% SPS=9.5um Density=2.24%
	Cell gap	Center point	3.2±0.2 um
	LC injection	Vacuum injection or ODF	ODF
	LC Margin	>6%	> 5%
	Pol compensation	A+C/B+B/None compensation film	None compensation film
	UV Glue	Fill out at IC around	Silicon Glue
	Pol surf. Treatment	Direct bonding: HC+Glare Air bonding: Haze44+glare(>4inch)	□□□□□
	Pol position	Direct bonding: pol is higher 0.05mm than M/F Air bonding: pol is lower 0.05mm than M/F	Yes
Package	Surface resistance	10 <sup>4</sup> ~10 <sup>9</sup> Ω	10 <sup>9</sup> ~10 <sup>11</sup> Ω
	Friction voltage	≤100V	≤100V
	Layer in one Box	<10layer	10Tray